- **Dual Output Voltages for Split-Supply Applications**
- **Selectable Power Up Sequencing for DSP Applications**
- **Output Current Range of 500 mA on Regulator 1 and 250 mA on Regulator 2**
- **Fast Transient Response**
- **Voltage Options are 3.3-V/2.5-V, 3.3-V/1.8-V, 3.3-V/1.5-V, 3.3-V/1.2-V, and Dual Adjustable Outputs**
- **Open Drain SVS (Power-On Reset) With 120-ms Delay**

- **Open Drain Power Good for Regulator1**
- **Ultra Low 190 μA (typ) Quiescent Current**
- **1 μA Input Current During Standby**
- **Low Noise: 65 μV_{RMS} Without Bypass Capacitor**
- **Quick Output Capacitor Discharge Feature**
- **Two Manual Reset Inputs**
- **2% Accuracy Over Load and Temperature**
- **Undervoltage Lockout (UVLO) Feature**
- **20-Pin PowerPAD™ TSSOP Package**
- **Thermal Shutdown Protection**

description

TPS701xx family devices are designed to provide a complete power management solution for DSP, processor power, ASIC, FPGA, and digital applications where dual output voltage regulators are required. Easy programmability of the sequencing function makes this family ideal for any DSP applications with power sequencing requirement. Differentiated features, such as accuracy, fast transient response, SVS supervisory circuit, manual reset inputs, and enable function, provide a complete system solution.

PWP PACKAGE
(TOP VIEW)

NC	1	20	NC
VIN1	2	19	VOUT1
VIN1	3	18	VOUT1
$\overline{MR1}$	4	17	VSENSE1/FB1
$\overline{MR2}$	5	16	PG1
EN	6	15	$\overline{RESET}$
SEQ	7	14	VSENSE2/FB2
GND	8	13	VOUT2
VIN2	9	12	VOUT2
VIN2	10	11	NC
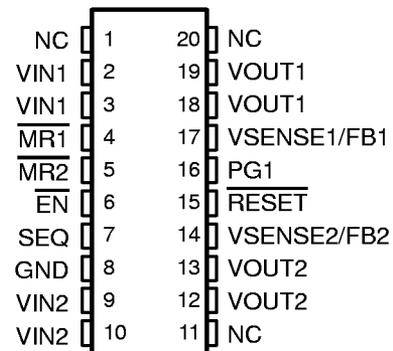
NC – No internal connection

TPS70151 PWP

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description (continued)

The TPS701xx family of voltage regulators offers very low dropout voltage and dual outputs with power up sequence control, which is designed primarily for DSP applications. These devices have extremely low noise output performance without using any added filter bypass capacitors and are designed to have a fast transient response and be stable with 10 uF low ESR capacitors.

These devices have fixed 3.3-V/2.5-V, 3.3-V/1.8-V, 3.3-V/1.5-V, 3.3-V/1.2-V, and adjustable/adjustable voltage options. The 3.3-V output regulator (regulator 1) can support up to 500 mA, and the other regulator (regulator 2) can support up to 250 mA. Separate voltage inputs allow the designer to configure the source power.

Because the PMOS device behaves as a low-value resistor, the dropout voltage is very low (typically 170 mV on regulator 1) and is directly proportional to the output current. Additionally, since the PMOS pass element is a voltage-driven device, the quiescent current is very low and independent of output loading (maximum of 225 μA over the full range of output current). This LDO family also features a sleep mode; applying a high signal to $\overline{EN}$ (enable) shuts down both regulators, reducing the input current to 1 μA at T_J = 25°C.

The device is enabled when the $\overline{EN}$ pin is connected to a low-level input voltage. The output voltages of the two regulators are sensed at the VSENSE1 and VSENSE2 pins respectively. The input signal at the SEQ pin controls the power-up sequence of the two regulators. When the device is enabled and the SEQ terminal is pulled high or left open, V_{out2} will turn on first and V_{out1} will remain off until V_{out2} reaches approximately 83% of it's regulated output voltage. At that time V_{out1} will be turned on. If V_{out2} is pulled below 83% (i.e. over load condition) V_{out1} will be turned off. Pulling the SEQ terminal low, reverses the power-up order and V_{out1} will be turned on first. The SEQ pin is connected to an internal pullup current source.

For each regulator, there is an internal discharge transistor to discharge the output capacitor when the regulator is turned off(disabled).

The PG1 pin reports the voltage conditions at the VOUT1, which can be used to implement a SVS (power on reset) for the circuitry supplied by regulator 1.

The TPS701xx features a $\overline{RESET}$ (SVS, POR, or Power On Reset). $\overline{RESET}$ output initiates a reset in DSP systems in the event of an undervoltage condition. $\overline{RESET}$ indicates the status of the V_{out2} and both manual reset pins ($\overline{MR1}$ and $\overline{MR2}$). When V_{out2} reaches 95% of it's regulated voltage and $\overline{MR1}$ and $\overline{MR2}$ are in the logic high state, $\overline{RESET}$ will go to a high impedance state after 120 ms delay. $\overline{RESET}$ will go to logic low state when V_{out2} regulated output voltage is pulled below 95% (i.e. over load condition) of it's regulated voltage. To monitor V_{out1} , the PG1 output pin can be connected to $\overline{MR1}$ or $\overline{MR2}$.

The device has an undervoltage lockout UVLO circuit which prevents the internal regulators from turning on until VIN1 reaches 2.5V.

AVAILABLE OPTIONS

T_J	REGULATOR 1 V_O (V)	REGULATOR 2 V_O (V)	TSSOP (PWP)
−40°C to 125°C	3.3 V	1.2 V	TPS70145PWP
	3.3 V	1.5 V	TPS70148PWP
	3.3 V	1.8 V	TPS70151PWP
	3.3 V	2.5 V	TPS70158PWP
	adjustable (1.22 V to 5.5 V)	adjustable (1.22 V to 5.5 V)	TPS70102PWP

NOTE: The TPS70102 is programmable using external resistor dividers (see application information) The PWP package is available taped and reeled. Add an R suffix to the device type (e.g., TPS70102PWPR).

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TPS70145, TPS70148, TPS70151, TPS70158, TPS70102
DUAL-OUTPUT LOW-DROPOUT VOLTAGE REGULATORS
**WITH POWER UP SEQUENCING FOR SPLIT VOLTAGE DSP SYSTEMS**

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detailed block diagram – fixed voltage version
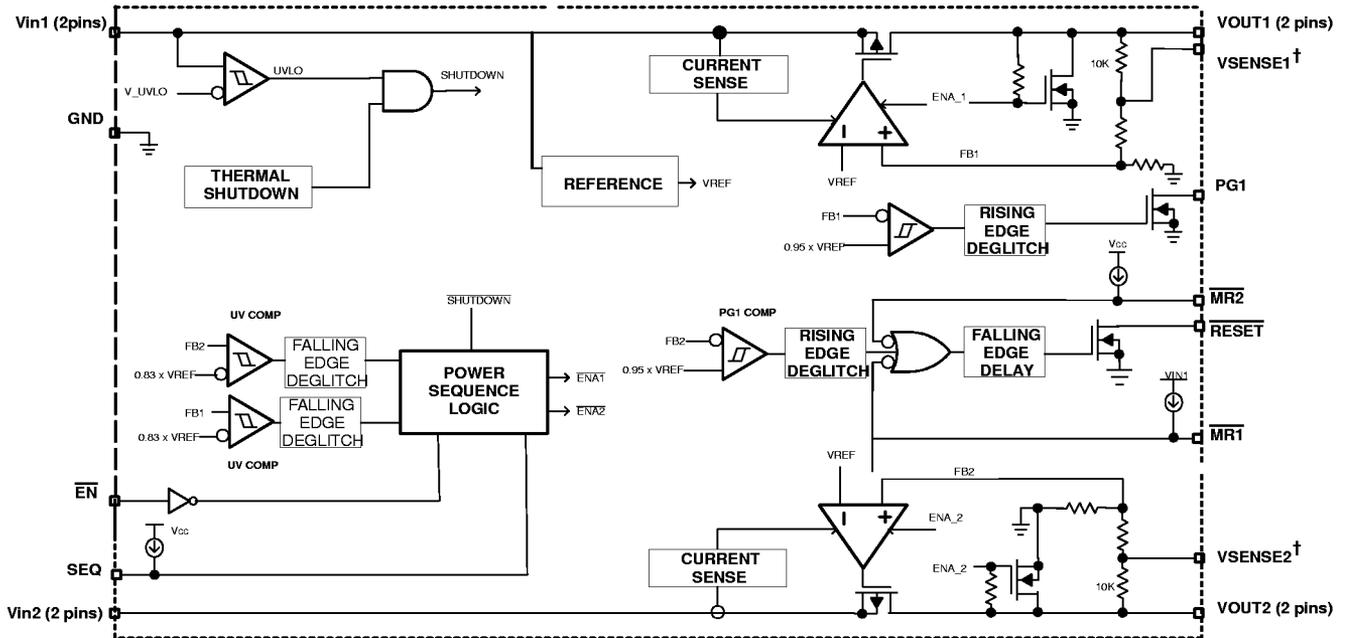
† For most applications, VSENSE1 and VSENSE2 should be externally connected to Vout as close as possible to the device. For other implementations, refer to SENSE terminal connection discussion in Application information section.

detailed block diagram – adjustable voltage version
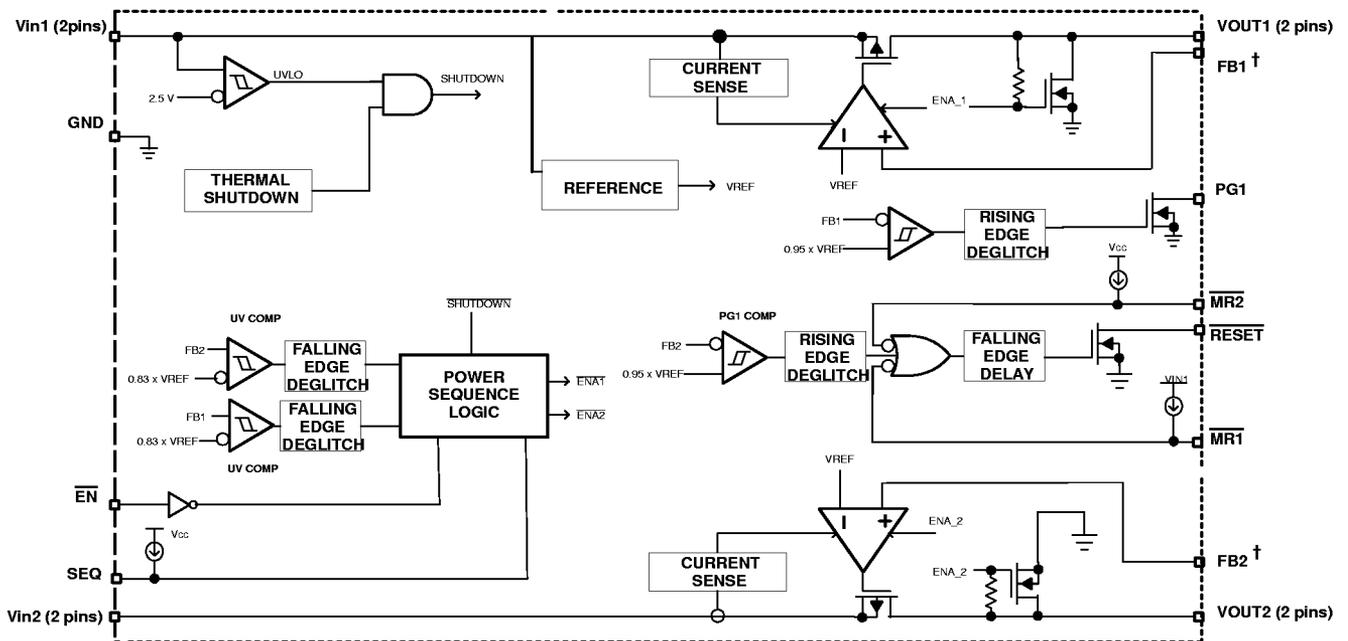
† For most applications, FB1 and FB2 should be externally connected to resistor dividers as close as possible to the device. For other implementations, refer to FB terminals connection discussion in Application information section.

timing diagram
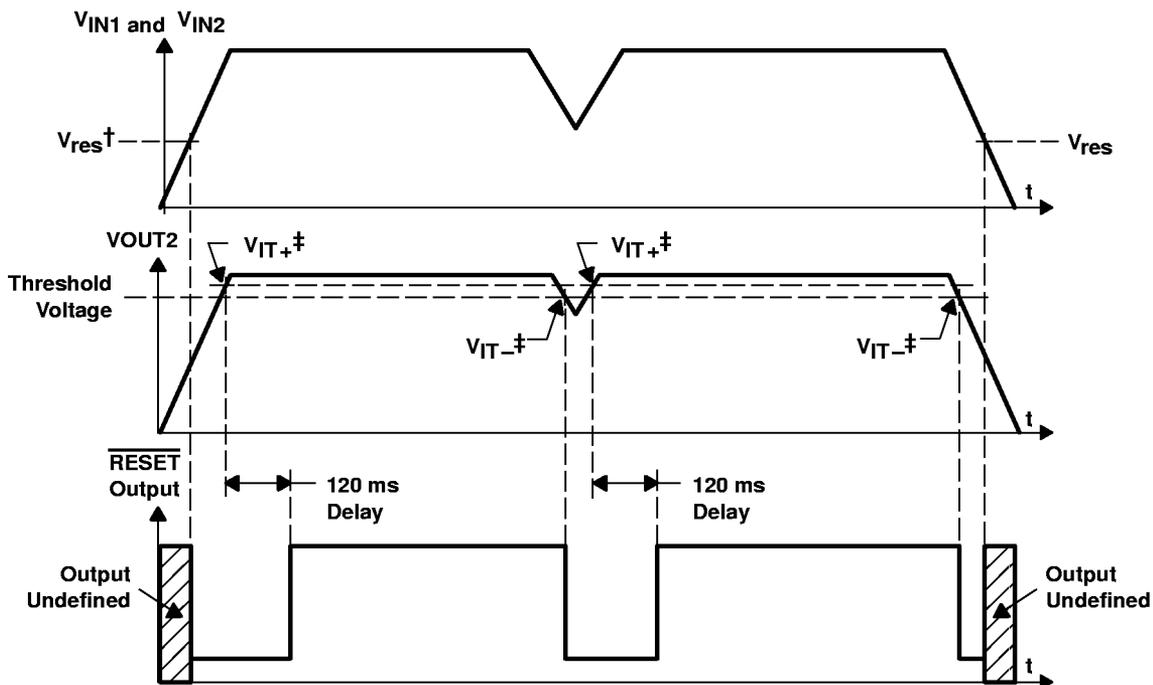
† V_{res} is the minimum input voltage for a valid $\overline{RESET}$. The symbol V_{res} is not currently listed within EIA or JEDEC standards for semiconductor symbology.

‡ VIT –Trip voltage is typically 5% lower than the output voltage (95%V_O) V_{IT-} to V_{IT+} is the hysteresis voltage.

Terminal Functions

TERMINAL		I/O	DESCRIPTION
NAME	NO.		
$\overline{EN}$	6	I	Active low enable
GND	8		Ground
$\overline{MR1}$	4	I	Manual reset input 1, active low, pulled up internally
$\overline{MR2}$	5	I	Manual reset input 2, active low, pulled up internally
NC	1, 11, 20		No connection
PG1	16	O	Open drain output, low when vout1 voltage is less than 55 of the nominal regulated voltage
$\overline{RESET}$	15	O	Open drain output, SVS (power on reset) signal, active low
SEQ	7	I	Power up sequence control: SEQ=High, VOUT2 powers up first; SEQ=Low, VOUT1 powers up first, SEQ terminal pulled up internally.
VIN1	2, 3	I	Input voltage of regulator 1
VIN2	9, 10	I	Input voltage of regulator 2
VOUT1	18, 19	O	Output voltage of regulator 1
VOUT2	12, 13	O	Output voltage of regulator 2
VSENSE2/FB2	14	I	Regulator 2 output voltage sense/ regulator 2 feedback for adjustable
VSENSE1/FB1	17	I	Regulator 1 output voltage sense/ regulator 2 feedback for adjustable

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absolute maximum ratings over operating junction temperature (unless otherwise noted)†

Input voltage range‡: V_I .... −0.3 V to 7 V
V_2 .... −0.3 V to 7 V
Voltage range at $\overline{EN}$ .... −0.3 V to 7 V
Output voltage range (VO1, VSENSE1) .... 5.5 V
Output voltage range (VO2, VSENSE2) .... 5.5 V
Maximum $\overline{RESET}$, PG1 voltage .... 7 V
Maximum $\overline{MR1}$, $\overline{MR2}$, and SEQ voltage VIN1
Peak output current .... Internally limited
Continuous total power dissipation .... See Dissipation Rating Tables
Operating virtual junction temperature range, T_J .... −40°C to 125°C
Storage temperature range, T_{stg} .... −65°C to 150°C
ESD rating, HBM .... 2 kV

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
‡ All voltages are tied to network ground

DISSIPATION RATING TABLE

PACKAGE	AIR FLOW (CFM)	$T_A \leq 25°C$	DERATING FACTOR	$T_A = 70°C$	$T_A = 85°C$
PWP§	0	3.067 W	30.67 mW/°C	1.687 W	1.227 W
	250	4.115 W	41.15 mW/°C	2.265 W	1.646 W

§ This parameter is measured with the recommended copper heat sink pattern on a 4-layer PCB, 1 oz. copper on 4-in × 4-in ground layer. For more information, refer to TI technical brief SLMA002.

recommended operating conditions

	MIN	MAX	UNIT
Input voltage, V_I¶	2.7	6	V
Output current, I_O (regulator 1)	0	500	mA
Output current, I_O (regulator 2)	0	250	mA
Output voltage range (for adjustable option)	1.22	5.5	V
Operating virtual junction temperature, T_J	−40	125	°C

¶ To calculate the minimum input voltage for maximum output current, use the following equation: $V_{I(min)} = V_{O(max)} + V_{DO(max\ load)}$.

DUAL-OUTPUT LOW-DROPOUT VOLTAGE REGULATORS
WITH POWER UP SEQUENCING FOR SPLIT VOLTAGE DSP SYSTEMS

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electrical characteristics over recommended operating junction temperature ($T_J = -40°C$ to $125°C$) $V_i = V_{O(nom)} + 1$ V, $I_O = 1$ mA, $\overline{EN} = 0$, $C_O = 33$ µF(unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
V_O	Output voltage (see Notes 1 and 3)	Adjustable voltage	1.22 V ≤ V_O ≤ 5.5 V, FB connected to Vo 2.7 V < V_{IN} < 6 V,		V_O		
			1.22 V ≤ V_O ≤ 5.5 V, FB connected to Vo 2.7 V < V_{IN} < 6 V,	$0.98V_O$		$1.02V_O$	
		1.2 V Output	2.7 V < V_{IN} < 6 V, $T_J = 25°C$		1.2		V
			2.7 V < V_{IN} < 6 V	1.176		1.224	
		1.5 V Output	2.7 V < V_{IN} < 6 V, $T_J = 25°C$		1.5		
			2.7 V < V_{IN} < 6 V	1.47		1.53	
		1.8 V Output	2.8 V < V_{IN} < 6 V, $T_J = 25°C$		1.8		
			2.8 V < V_{IN} < 6 V	1.764		1.836	
		2.5 V Output	3.5 V < V_{IN} < 6 V, $T_J = 25°C$		2.5		
			3.5 V < V_{IN} < 6 V	2.45		2.55	
		3.3 V Output	4.3 V < V_{IN} < 6 V, $T_J = 25°C$		3.3		V
			4.3 V < V_{IN} < 6 V	3.234		3.366	
Quiescent current (GND current) for regulator 1 and regulator 2, $\overline{EN} = 0$ V, (see Note 1)			See Note 3, $T_J = 25°C$		190		µA
			See Note 3			230	
Output voltage line regulation ($\Delta V_O/V_O$) regulator 1 (see Note 2)			$V_O + 1$ V < V_I ≤ 6 V, $T_J = 25°C$, See Note 1		0.01%		V
			$V_O + 1$ V < V_I ≤ 6 V, See Note 1			0.1%	V
Output voltage line regulation ($\Delta V_O/V_O$) regulator 2 (see Note 2)			$V_O + 1$ V < V_I ≤ 6 V, $T_J = 25°C$, See Note 1		0.01%		V
			$V_O + 1$ V < V_I ≤ 6 V, See Note 1			0.1%	V
Load regulation for Vout1			$T_J = 25°C$		1		mV
Load regulation for Vout2			$T_J = 25°C$		1		mV
V_n Output noise voltage (regulator 1)			BW = 300 Hz to 50 kHz, $C_O = 33$ µF, $T_J = 25°C$		65		µVrms
V_n Output noise voltage (regulator 2)			BW = 300 Hz to 50 kHz, $C_O = 33$ µF, $T_J = 25°C$		65		µVrms
Output current Limit for regulator 1			$V_O = 0$ V_I		1.6	1.9	A
Output current Limit for regulator 2			$V_O = 0$ V_I		0.750	1	A
Thermal shutdown junction temperature			$T_J = 25°C$		150		°C
$I_{I(standby)}$ Standby current for regulator 1			$\overline{EN} = V_I$, $T_J = 25°C$			1	µA
$I_{I(standby)}$ Standby current for regulator 1			$\overline{EN} = V_I$			3	µA
$I_{I(standby)}$ Standby current for regulator 2			$\overline{EN} = V_I$, $T_J = 25°C$			1	µA
$I_{I(standby)}$ Standby current for regulator 2			$\overline{EN} = V_I$			3	µA
PSRR Power supply ripple rejection			f = 1 kHz, $C_O = 33$ µF, $T_J = 25°C$, See Note 1		60		dB

NOTES: 1.   Minimum input operating voltage is 2.7 V or $V_{O(typ)} + 1$ V, whichever is greater. Maximum input voltage = 6 V, minimum output current 1 mA.

2.   If $V_O < 1.8$ V then $V_{imax} = 6$ V, $V_{imin} = 2.7$ V:

$$\text{Line Regulation (mV)} = (\%/V) \times \frac{V_O(V_{imax} - 2.7\text{ V})}{100} \times 1000$$

If $V_O > 2.5$ V then $V_{imax} = 6$ V, $V_{imin} = V_O + 1$ V:

$$\text{Line Regulation (mV)} = (\%/V) \times \frac{V_O(V_{imax} - (V_O + 1))}{100} \times 1000$$

3. $I_O = 1$ mA to 500 mA for Regulator 1 and 1 mA to 250 mA for Regulator 2.

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DUAL-OUTPUT LOW-DROPOUT VOLTAGE REGULATORS
WITH POWER UP SEQUENCING FOR SPLIT VOLTAGE DSP SYSTEMS

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electrical characteristics over recommended operating junction temperature (T_J = –40°C to 125°C) V_i = $V_{O(nom)}$ + 1 V, I_O = 1 mA, $\overline{EN}$ = 0, C_O = 33 µF(unless otherwise noted) (continued)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
RESET	Minimum input voltage for valid $\overline{RESET}$	$I_{(RESET)}$ = 300 µA, $V_{(RESET)}$ ≤ 0.8 V		1.0	1.3	V
	Trip threshold voltage	V_O decreasing	92%		98%	V_O
	Hysteresis voltage	Measured at V_O		0.5%		V_O
	$t_{(RESET)}$	$\overline{RESET}$ pulse duration	80	120	160	ms
	$t_{r\overline{RESET}}$	Rising edge deglitch		30		µs
	Output low voltage	V_I = 3.5 V, $I_{O(RESET)}$ = 1 mA		0.15	0.4	V
	Leakage current	$V_{(RESET)}$ = 6 V			1	µA
PG	Minimum input voltage for valid PG	$I_{O(PG)}$ = 300 µA, $V_{(PG1)}$ ≤ 0.8 V		1.0	1.3	V
	Trip threshold voltage	V_O decreasing	92%		98%	V_O
	Hysteresis voltage	Measured at V_O		0.5%		V_O
	trPG1	Rising edge deglitch		30		µs
	Output low voltage	V_I = 2.7 V, $I_{O(PG)}$ = 1 mA		0.15	0.4	V
	Leakage current	$V_{(PG1)}$ = 6 V			1	µA
EN	High level $\overline{EN}$ input voltage		2			V
	Low level $\overline{EN}$ input voltage				0.7	V
	Input current ($\overline{EN}$)		–1		1	µA
	Falling Edge deglitch	Measured at V_O		140		µs
SEQ	High level SEQ input voltage		2			V
	Low level SEQ input voltage				0.7	V
	Falling edge deglitch	Measured at V_O		140		µs
	SEQ pull up current source			6		µA
MR1 / MR2	High level input voltage		2			V
	Low level input voltage				0.7	V
	Falling edge deglitch	Measured at V_O		140		µs
	pull up current source			6		µA
VOUT2	VOUT2 UV comparator – pPositive-going input threshold voltage of VOUT1 UV comparator		80% Vo	83% Vo	86% Vo	V
	VOUT2 UV comparator – hysteresis			0.5% Vo		mV
	VOUT2 UV comparator – falling edge deglitch	V_{SENSE_2} decreasing below threshold		140		µs
	Peak output current	2 ms pulse width		375		mA
	Discharge transistor current	Vout2 = 1.5 V		7.5		mA
VOUT1	VOUT1 UV comparator – positive-going input threshold voltage of VOUT1 UV comparator		80% Vo	83% Vo	86% Vo	V
	VOUT1 UV comparator – hysteresis			0.5% Vo		mV
	VOUT1 UV comparator – falling edge deglitch	V_{SENSE_1} decreasing below threshold		140		µs
	Dropout voltage (see Note 4)	I_O = 500 mA, Vin1 = 3.2 V		170		mV
		I_O = 500 mA, Vin1 = 3.2 V			275	
	Peak output current	2 ms pulse width		750		mA
	Discharge transistor current	Vout1 = 1.5 V		7.5		mA
VOUT1 UV$_{LO}$	UVLO threshold		2.4		2.65	V

NOTE 4: Input voltage(VIN1 or VIN2) = Vo(Typ) – 100 mV. 1.5 V, 1.8 V and 2.5 V regulators, the dropout voltage is limited by input voltage range. The 3.3 V regulator input voltage is to 3.2 V to perform this test.

Table of Graphs

			FIGURE
V_O	Output voltage	vs Output current	1 – 3
		vs Temperature	4 – 7
	Ground current	vs Temperature	8, 9
PSRR	Power supply rejection ratio	vs Frequency	10 – 13
	Output spectral noise density	vs Frequency	14 – 17
Z_O	Output impedance	vs Frequency	18 – 21
	Dropout voltage	vs Temperature	22, 23
		vs Input voltage	24, 25
	Load transient response		26, 27
	Line transient response		28, 29
	Output voltage	vs. Time (start-up)	30, 31
Stability	Equivalent series resistance (ESR)	vs Output current	33 – 36

TYPICAL CHARACTERISTICS

TPS70151
OUTPUT VOLTAGE
vs
OUTPUT CURRENT
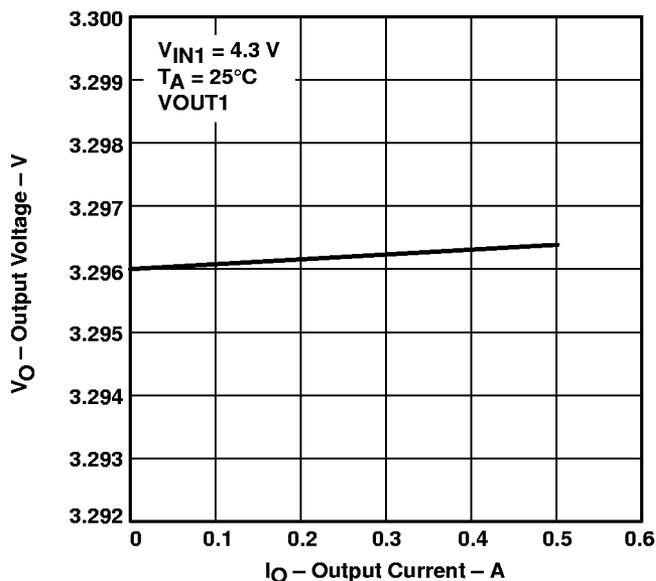
Figure 1

TPS70151
OUTPUT VOLTAGE
vs
OUTPUT CURRENT

Figure 2

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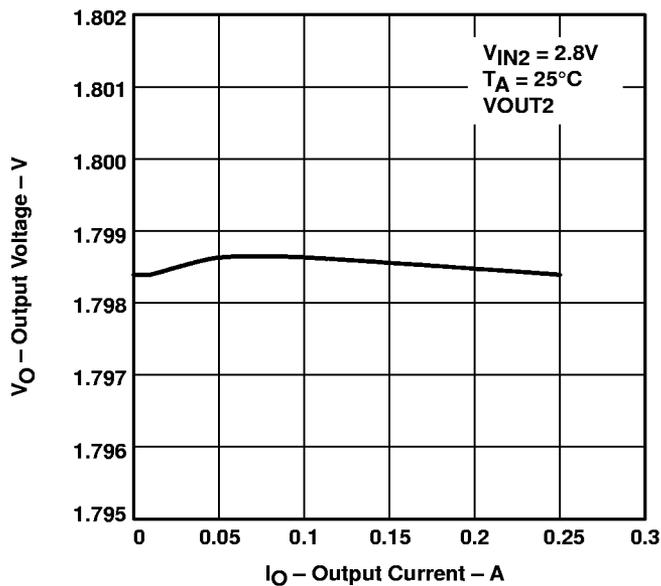
TYPICAL CHARACTERISTICS

TPS70145
OUTPUT VOLTAGE
vs
OUTPUT CURRENT
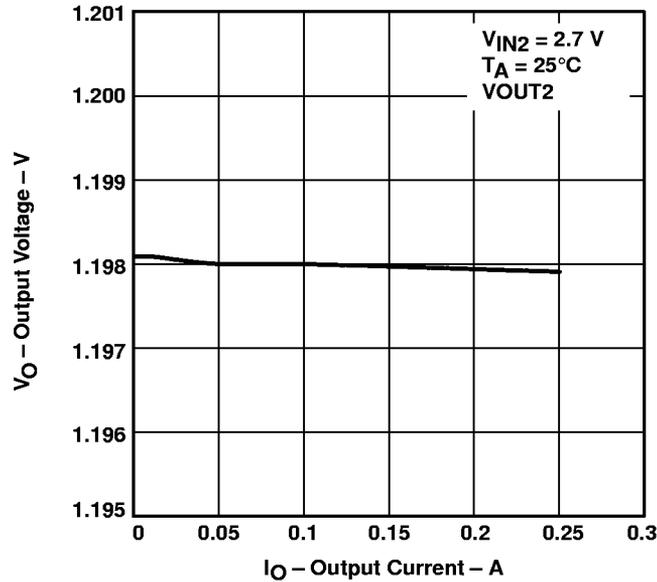
Figure 3

TPS70151
OUTPUT VOLTAGE
vs
TEMPERATURE
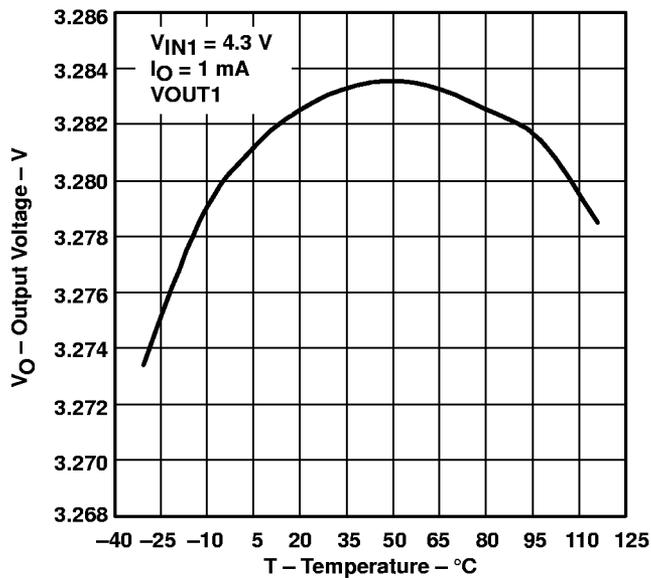
Figure 4

TPS70151
OUTPUT VOLTAGE
vs
TEMPERATURE
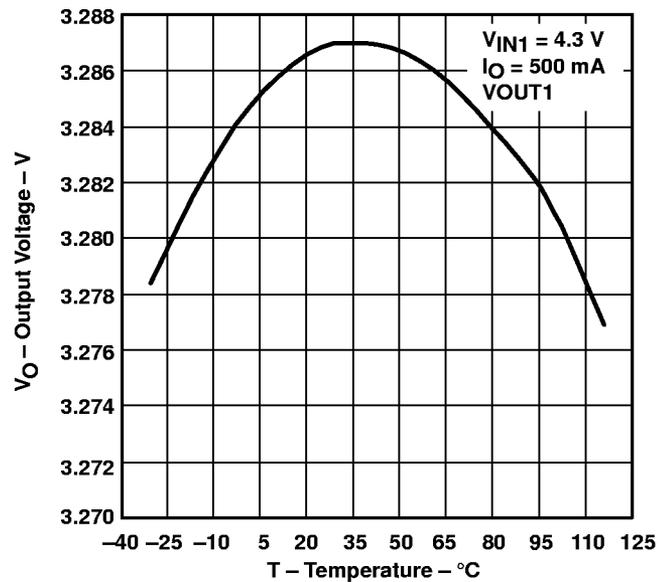
Figure 5

TYPICAL CHARACTERISTICS

TPS70151
OUTPUT VOLTAGE
vs
TEMPERATURE
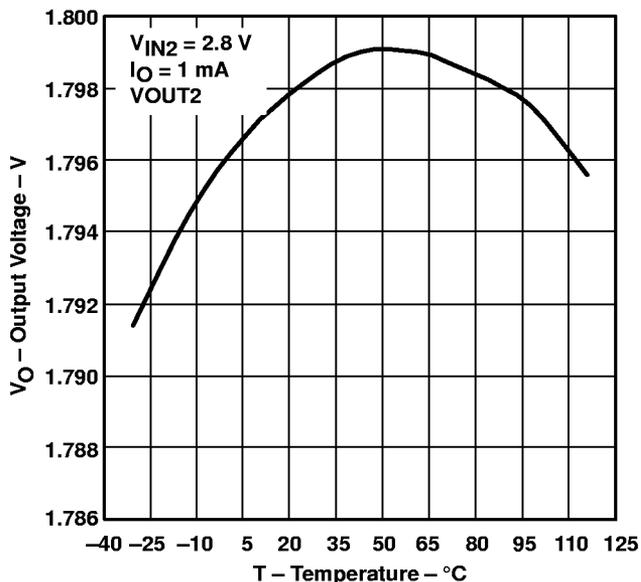
Figure 6

TPS70151
OUTPUT VOLTAGE
vs
TEMPERATURE
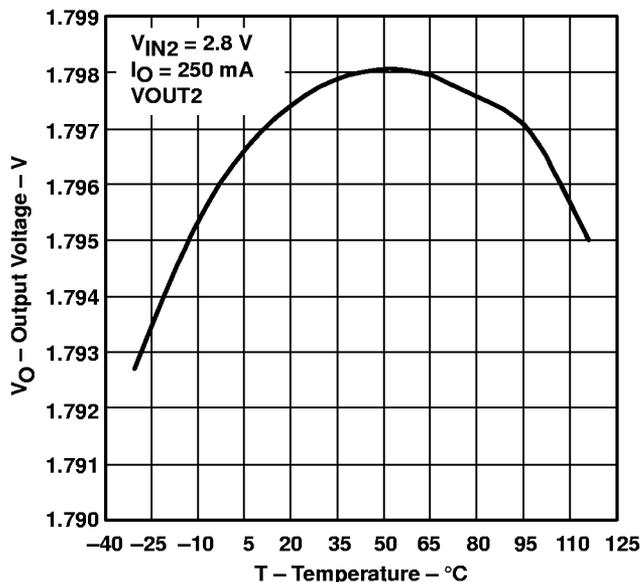
Figure 7

GROUND CURRENT
vs
TEMPERATURE
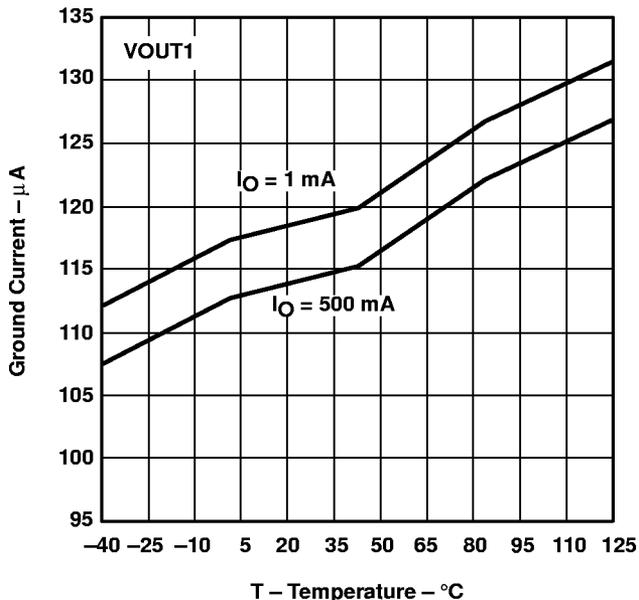
Figure 8

GROUND CURRENT
vs
TEMPERATURE
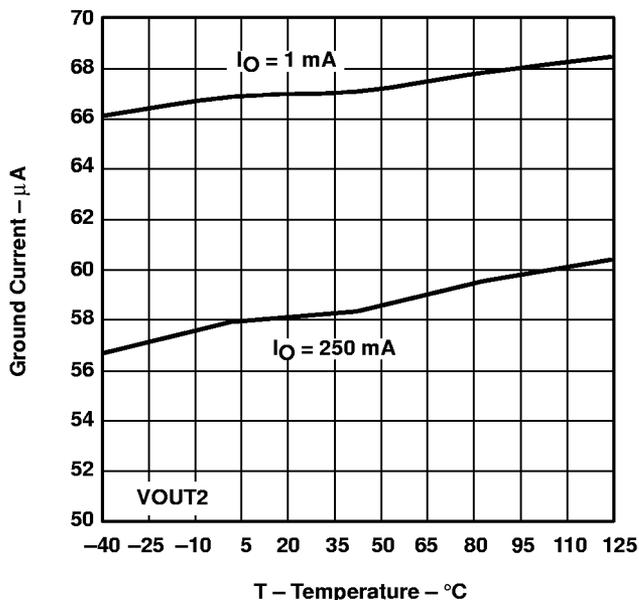
Figure 9

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TYPICAL CHARACTERISTICS

TPS70151
POWER SUPPLY REJECTION RATIO
vs
FREQUENCY

Figure 10

TPS70151
POWER SUPPLY REJECTION RATIO
vs
FREQUENCY

Figure 11

TPS70151
POWER SUPPLY REJECTION RATIO
vs
FREQUENCY

Figure 12

TPS70151
POWER SUPPLY REJECTION RATIO
vs
FREQUENCY

Figure 13

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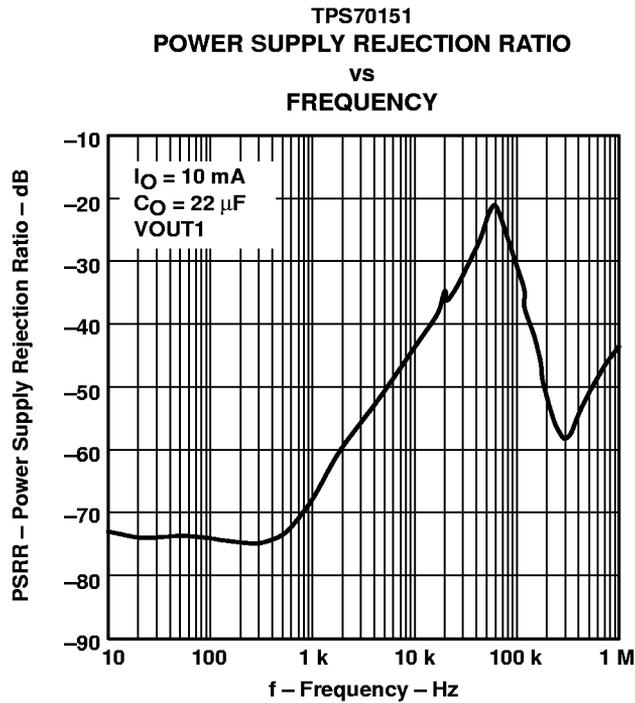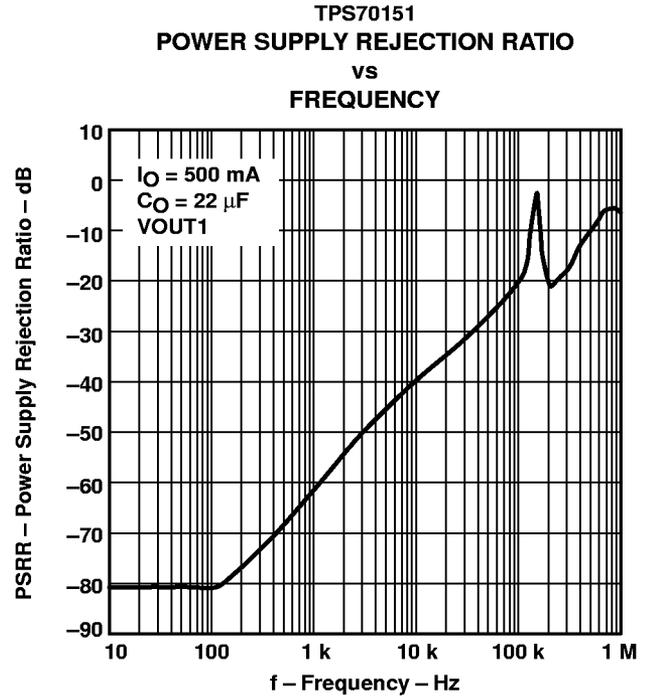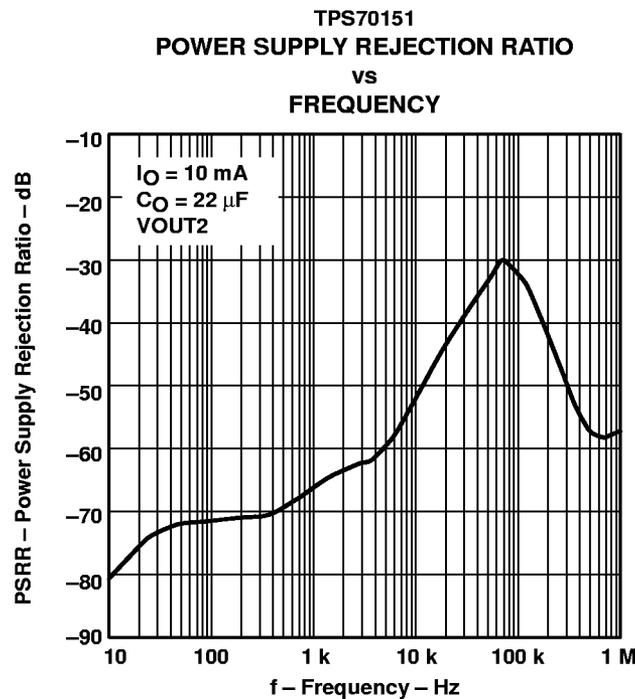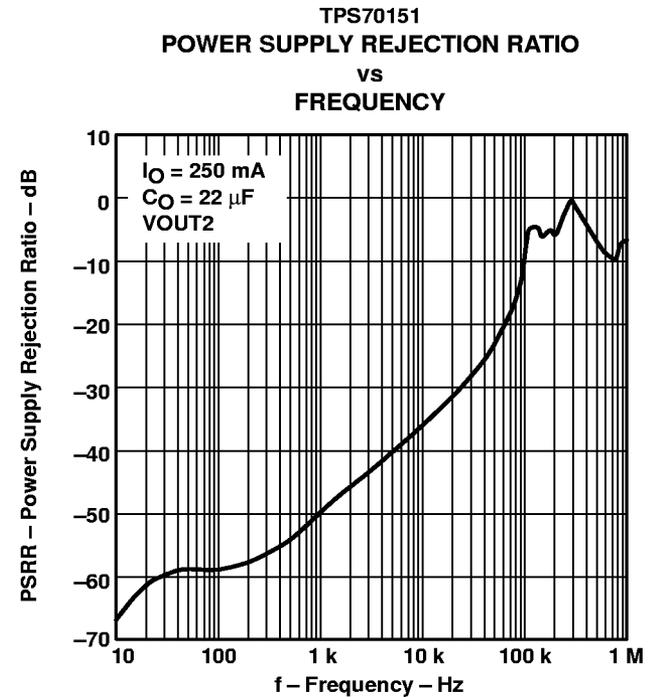
TYPICAL CHARACTERISTICS

OUTPUT SPECTRAL NOISE DENSITY
vs
FREQUENCY
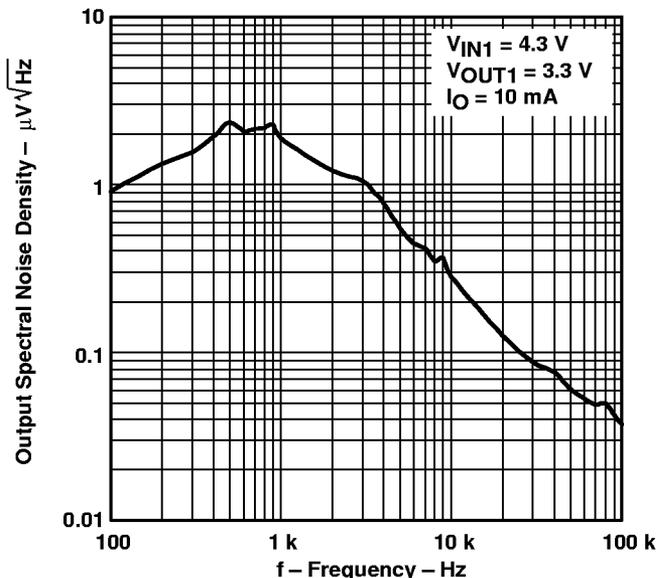
Figure 14

OUTPUT SPECTRAL NOISE DENSITY
vs
FREQUENCY
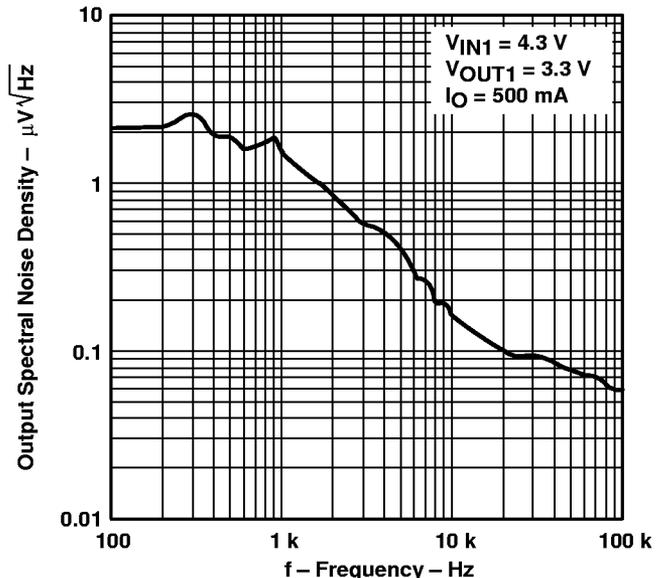
Figure 15

OUTPUT SPECTRAL NOISE DENSITY
vs
FREQUENCY
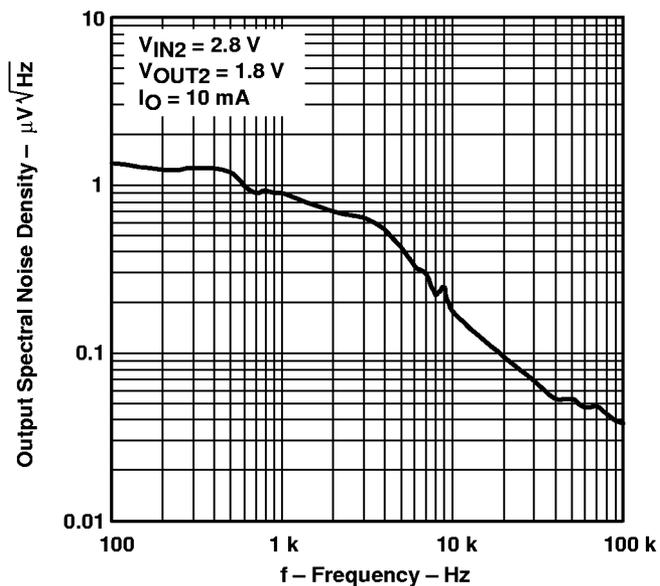
Figure 16

OUTPUT SPECTRAL NOISE DENSITY
vs
FREQUENCY

Figure 17

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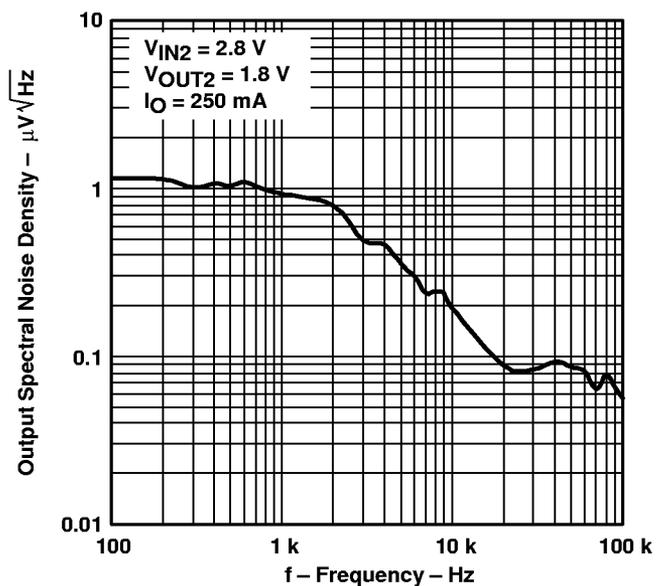
TYPICAL CHARACTERISTICS

OUTPUT IMPEDANCE
vs
FREQUENCY

$C_O = 33 \mu F$
$I_O = 500 mA$
$V_O = 3.3 V$
$T_A = 25 C$
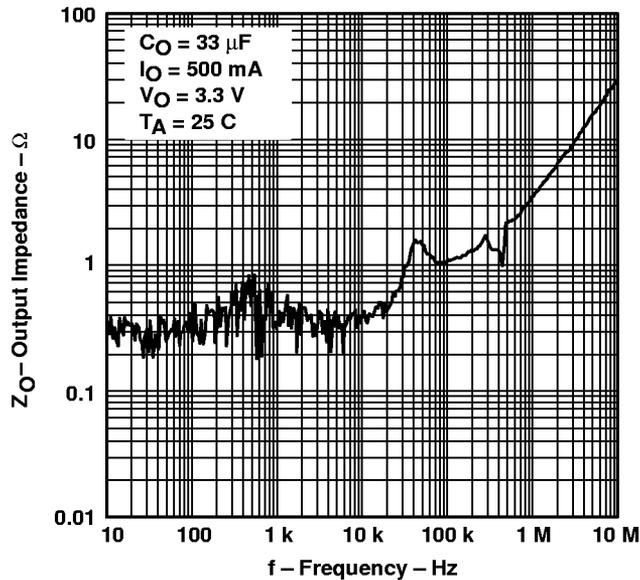
Figure 18

OUTPUT IMPEDANCE
vs
FREQUENCY

$C_O = 33 \mu F$
$I_O = 10 mA$
$V_O = 3.3 V$
$T_A = 25 C$
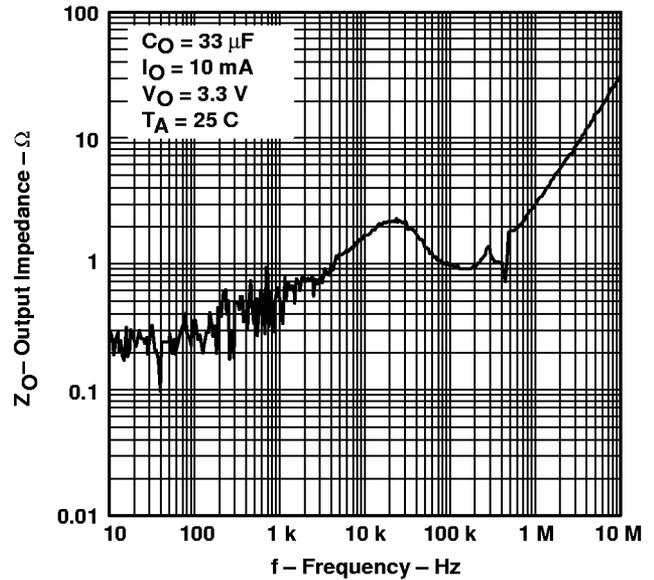
Figure 19

OUTPUT IMPEDANCE
vs
FREQUENCY

$C_O = 33 \mu F$
$I_O = 250 mA$
$V_O = 1.8 V$
$T_A = 25 C$
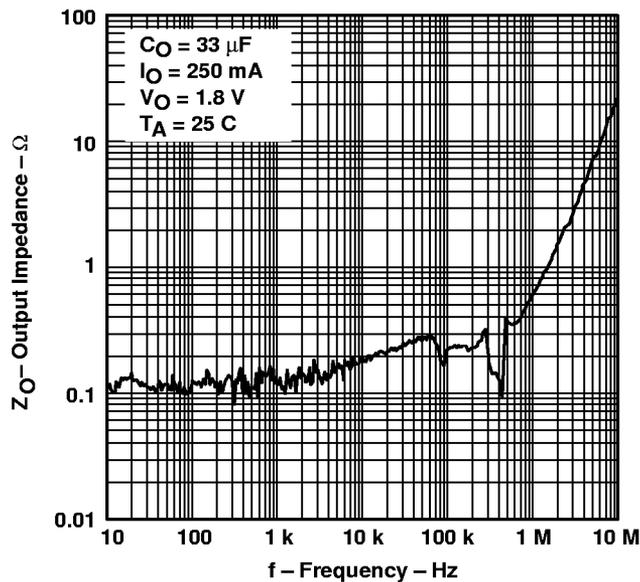
Figure 20

OUTPUT IMPEDANCE
vs
FREQUENCY

$C_O = 33 \mu F$
$I_O = 10 mA$
$V_O = 1.8 V$
$T_A = 25 C$
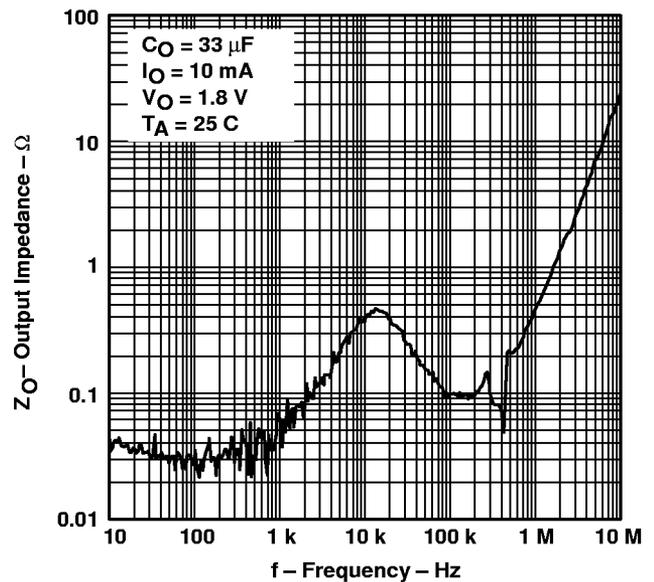
Figure 21

TPS70145, TPS70148, TPS70151, TPS70158, TPS70102
DUAL-OUTPUT LOW-DROPOUT VOLTAGE REGULATORS
WITH POWER UP SEQUENCING FOR SPLIT VOLTAGE DSP SYSTEMS

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## TYPICAL CHARACTERISTICS

DROPOUT VOLTAGE
vs
TEMPERATURE

$C_O = 33 \ \mu F$
$VIN1 = 3.2 \ V$

$I_O = 500 \ mA$

Dropout Voltage – mV
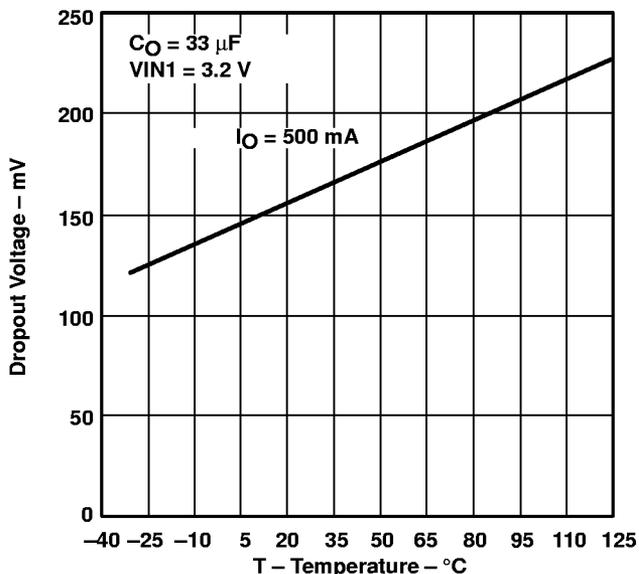
T – Temperature – °C

Figure 22

DROPOUT VOLTAGE
vs
TEMPERATURE

$C_O = 33 \ \mu F$
$VIN1 = 3.2 \ V$

$I_O = 10 \ mA$

$I_O = 0 \ mA$

Dropout Voltage – mV

T – Temperature – °C
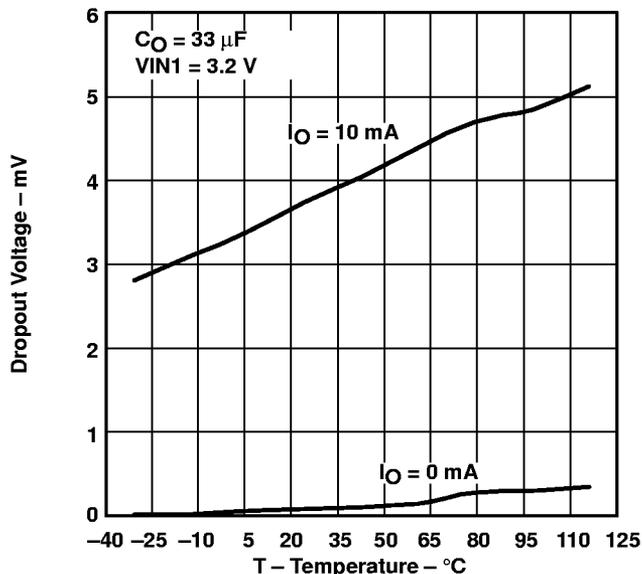
Figure 23

TPS70101
DROPOUT VOLTAGE
vs
INPUT VOLTAGE

$I_O = 500 \ mA$
VIN1

$T_J = 125°C$

$T_J = 25°C$

$T_J = -40°C$

Dropout Voltage – mV
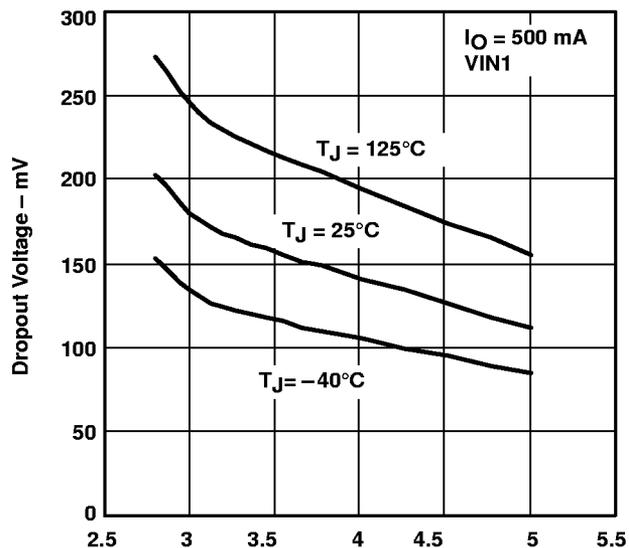
V_I – Input Voltage – V

Figure 24

TPS70101
DROPOUT VOLTAGE
vs
INPUT VOLTAGE
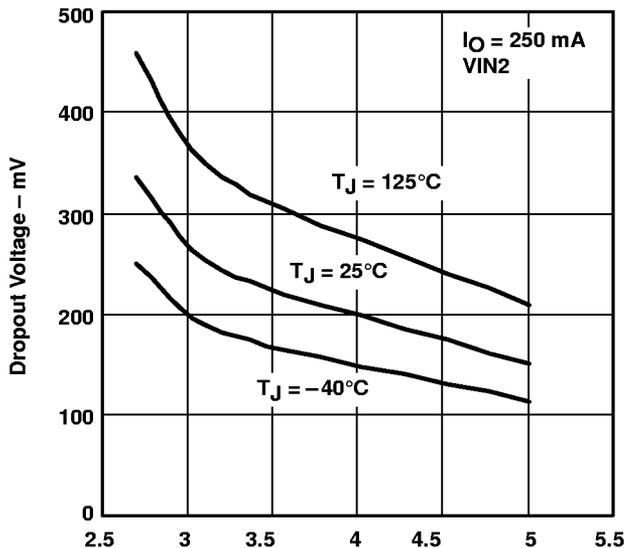
$I_O = 250 \ mA$
VIN2

$T_J = 125°C$

$T_J = 25°C$

$T_J = -40°C$

Dropout Voltage – mV

V_I – Input Voltage – V

Figure 25

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TYPICAL CHARACTERISTICS

LOAD TRANSIENT RESPONSE

$C_O = 33 \mu F$
$T_A = 25°C$
VOUT1 = 3.3 V

Figure 26

LOAD TRANSIENT RESPONSE

$C_O = 33 \mu F$
$T_A = 25°C$
VOUT1 = 1.8 V

Figure 27

LINE TRANSIENT RESPONSE (VOUT1)

$I_O = 500$ mA
$C_O = 33 \mu F$

Figure 28

LINE TRANSIENT RESPONSE (VOUT2)

$I_O = 250$ mA
$C_O = 33 \mu F$

Figure 29

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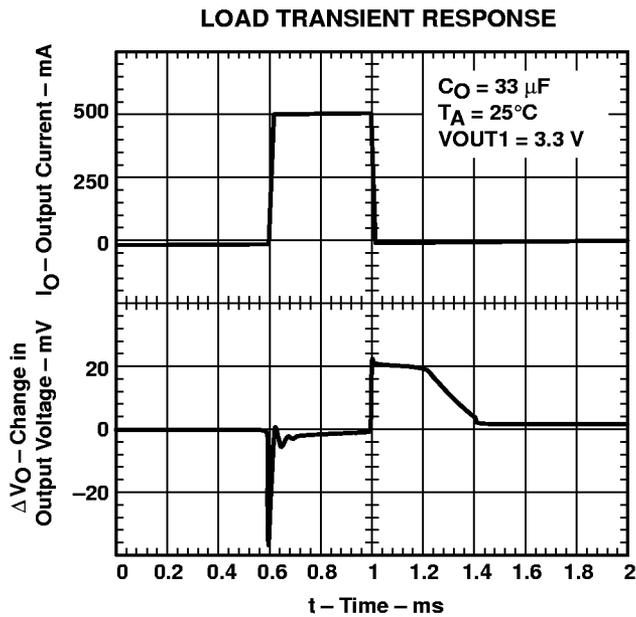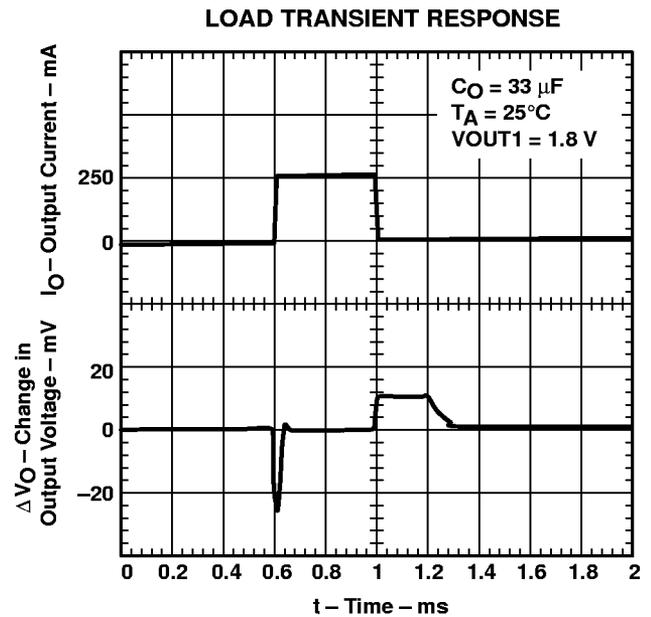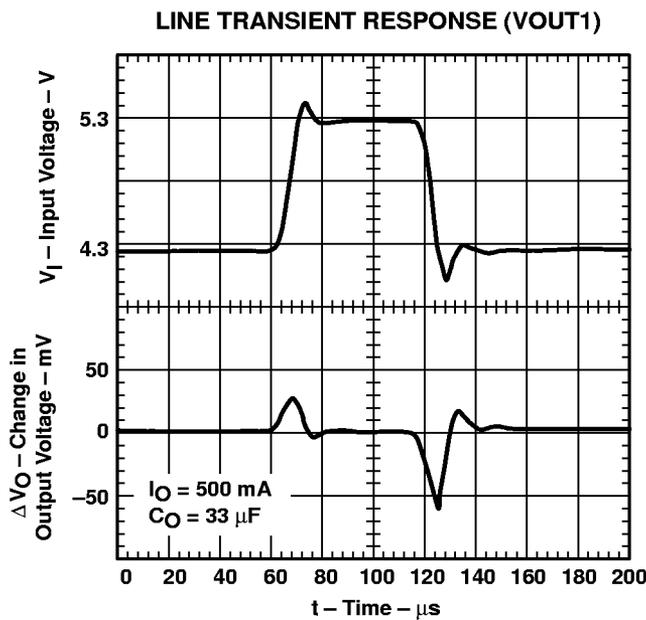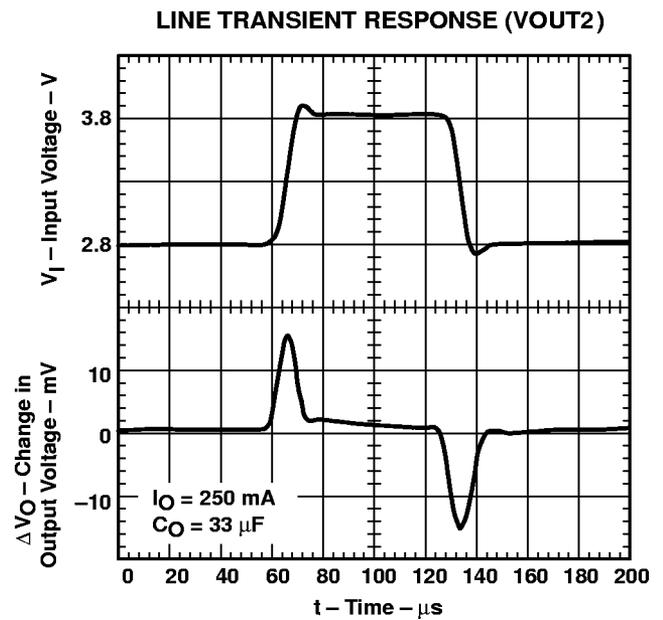
TYPICAL CHARACTERISTICS

OUTPUT VOLTAGE
vs
TIME (START-UP)

$V_O = 3.3$ V
$C_O = 33$ μF
$I_O = 500$ mA
VOUT1
SEQ = Low
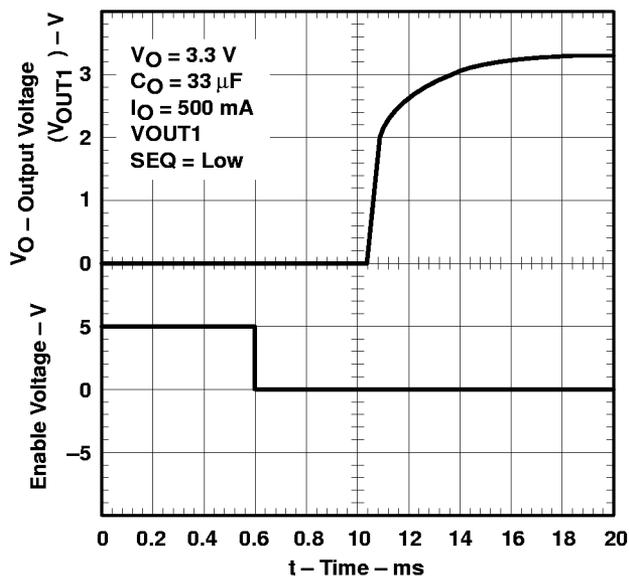
Figure 30

OUTPUT VOLTAGE
vs
TIME (START-UP)

$V_O = 1.8$ V
$C_O = 33$ μF
$I_O = 250$ mA
VOUT2
SEQ = High
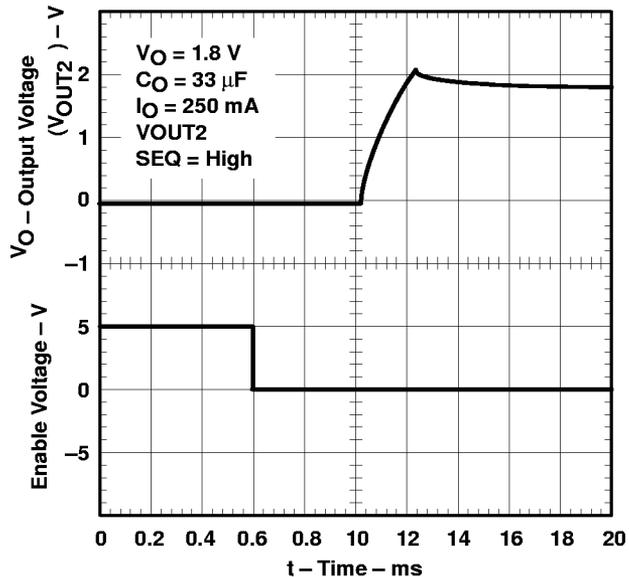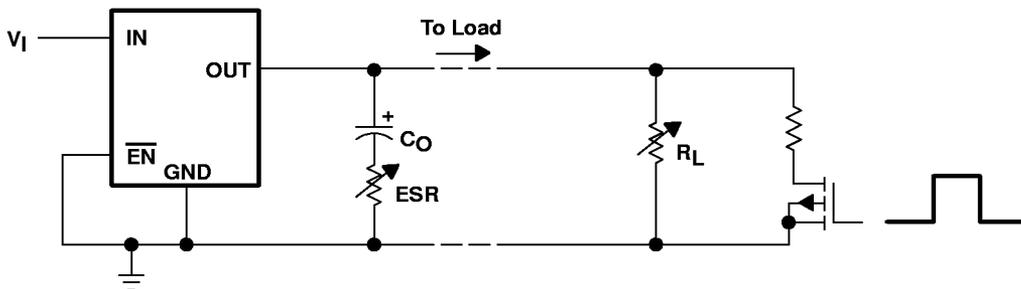
Figure 31

Figure 32. Test Circuit for Typical Regions of Stability

† Equivalent series resistance (ESR) refers to the total series resistance, including the ESR of the capacitor, any series resistance added externally, and PWB trace resistance to C_O.

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TYPICAL CHARACTERISTICS

TYPICAL REGION OF STABILITY
EQUIVALENT SERIES RESISTANCE†
vs
OUTPUT CURRENT
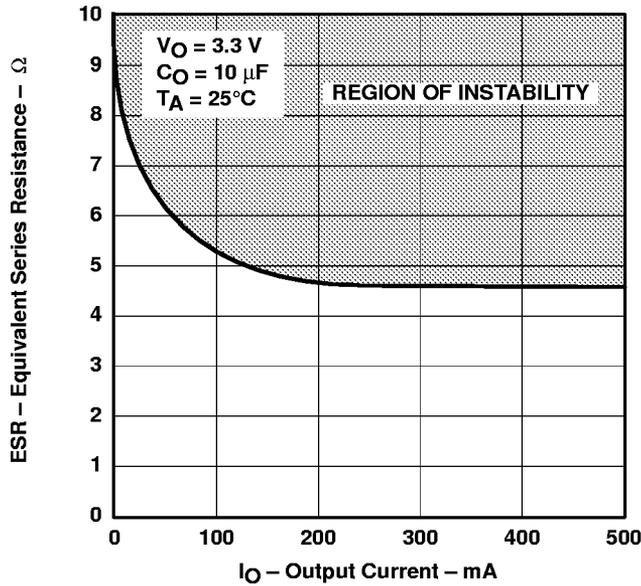
Figure 33

TYPICAL REGION OF STABILITY
EQUIVALENT SERIES RESISTANCE†
vs
OUTPUT CURRENT
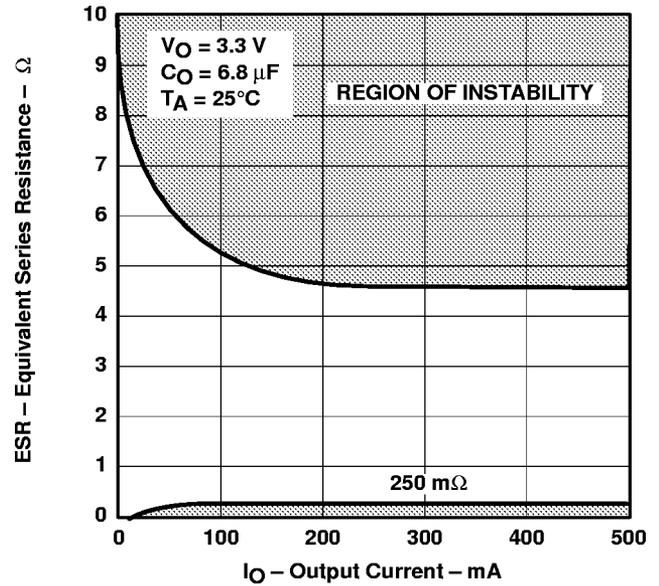
Figure 34

TYPICAL REGION OF STABILITY
EQUIVALENT SERIES RESISTANCE†
vs
OUTPUT CURRENT
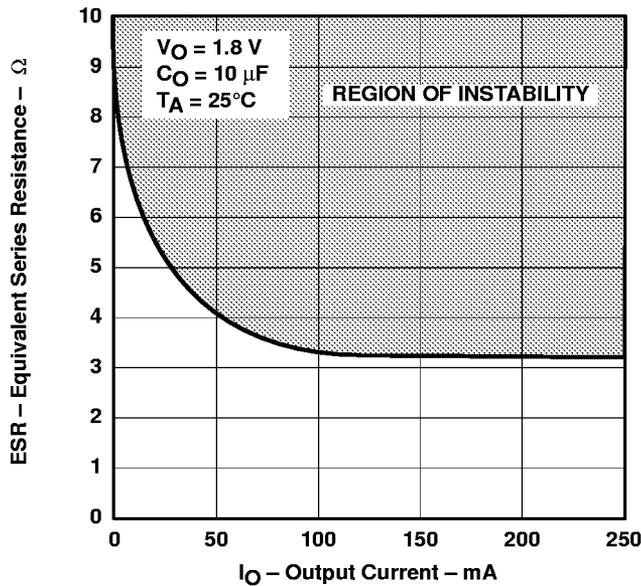
Figure 35

TYPICAL REGION OF STABILITY
EQUIVALENT SERIES RESISTANCE†
vs
OUTPUT CURRENT
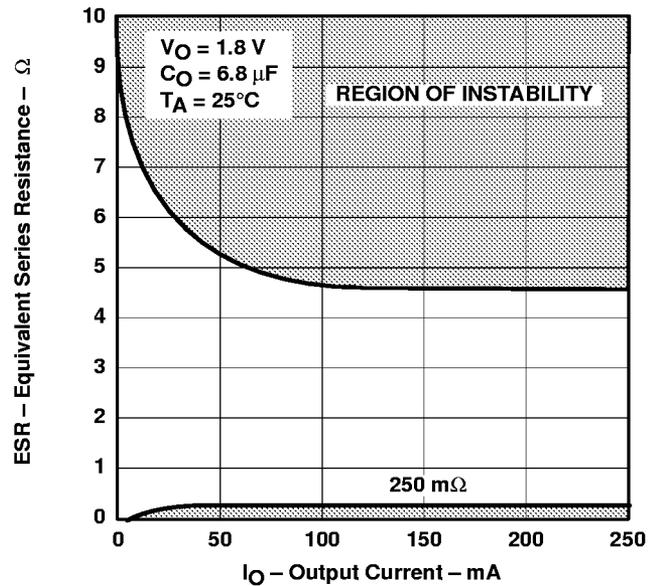
Figure 36

† Equivalent series resistance (ESR) refers to the total series resistance, including the ESR of the capacitor, any series resistance added externally, and PWB trace resistance to C_O.

APPLICATION INFORMATION

pin functions

enable

The $\overline{\text{EN}}$ terminal is an input which enables or shuts down the device. If $\overline{\text{EN}}$ is at a voltage high signal the device will be in shutdown mode. When the $\overline{\text{EN}}$ goes to voltage low, then the device will be enabled.

sequence

The SEQ terminal is an input that programs which output voltage (V_{out1} or V_{out2}) will be turned on first. When the device is enabled and the SEQ terminal is pulled high or left open, V_{out2} will turn on first and V_{out1} will remain off until V_{out2} reaches approximately 83% of its regulated output voltage. At that time the V_{out1} will be turned on. If V_{out2} is pulled below 83% (i.e., over load condition) V_{out1} will be turned off. For a detailed timing diagram, refer to Figures 37 – 43. These terminals have a 6-μA pullup current to VIN1.

Pulling the SEQ terminal low reverses the power-up order and V_{out1} will be turned on first. For detail timing diagram refer to Figures 37 and 42.

power–good

The PG1 is an open drain, active high output terminal which indicates the status of the V_{out1} regulator. When the V_{out1} reaches 95% of its regulated voltage, PG1 will go to a high impedance state. It will be a logic low state when it is pulled below 95% (i.e. over load condition) of its regulated voltage. The open drain output of the PG1 terminal requires a pullup resistor.

manual reset pins ($\overline{\text{MR1}}$ and $\overline{\text{MR2}}$)

$\overline{\text{MR1}}$ and $\overline{\text{MR2}}$ are active low input terminals used to trigger a reset condition. When either $\overline{\text{MR1}}$ or $\overline{\text{MR2}}$ is pulled to logic low, a POR ($\overline{\text{RESET}}$) will occur. These terminals have a 6-μA pullup current to VIN1.

sense (VSENSE1, VSENSE2)

The sense terminals of fixed-output options must be connected to the regulator output, and the connection should be as short as possible. Internally, sense connects to high-impedance wide-bandwidth amplifiers through a resistor-divider network and noise pickup feeds through to the regulator output. It is essential to route the sense connection in such a way to minimize/avoid noise pickup. Adding RC networks between sense terminals and Vouts to filter noise is not recommended because it can cause the regulators to oscillate.

FB1 and FB2

FB1 and FB2 are input terminals used for adjustable-output devices and must be connected to the external feedback resistor divider. FB1 and FB2 connections should be as short as possible. it is essential to route them in such a way as to minimize/avoid noise pickup. Adding RC networks between FB terminals and Vouts to filter noise is not recommended because it can cause the regulators to oscillate.

$\overline{\text{RESET}}$ indicator

The TPS701xx features a $\overline{\text{RESET}}$ (SVS, POR, or Power On Reset). $\overline{\text{RESET}}$ can be used to drive power-on reset circuitry or a low-battery indicator. $\overline{\text{RESET}}$ is an active low, open drain output which indicates the status of the V_{out2} regulator and both manual reset pins ($\overline{\text{MR1}}$ and $\overline{\text{MR2}}$). When V_{out2} exceeds to 95% of it's regulated voltage, and $\overline{\text{MR1}}$ and $\overline{\text{MR2}}$ are in the logic high state, $\overline{\text{RESET}}$ will go to a high-impedance state after 120-ms delay. $\overline{\text{RESET}}$ will go to a logic low state when V_{out2} is pulled below 95% (i.e. over load condition) of it's regulated voltage. To monitor V_{out1}, PG1 output pin can be connected to $\overline{\text{MR1}}$ or $\overline{\text{MR2}}$. The open drain output of the $\overline{\text{RESET}}$ terminal requires a pullup resistor. If $\overline{\text{RESET}}$ is not used, it can be left floating.

VIN1 and VIN2

VIN1 and VIN2 are input to the regulators. Internal bias voltages are powered by VIN1.

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APPLICATION INFORMATION

The TPS701xx low dropout regulator family provides dual regulated output voltages for DSP applications, which require high performance power management solution. These devices provide fast transient response and high accuracy with small output capacitors, while drawing low quiescent current. Programmable sequencing provides a power solution for DSPs without any external component requirements. This reduces the component cost and board space while increasing total system reliability. TPS701xx family has an enable feature which puts the device in sleep mode where input currents are less than 3 μA. Other features are integrated SVS (Power On Reset, $\overline{\text{RESET}}$) and Power Good (PG1) that monitor output voltages and provide logic output to the system. These differentiated features provide a complete DSP power solution.

The TPS701xx, unlike many other LDOs, feature, very low quiescent current which remains virtually constant even with varying loads. Conventional LDO regulators use a pnp pass element, the base current of which is directly proportional to the load current through the regulator ($I_B = I_C/\beta$). The TPS701xx uses a PMOS transistor to pass current; because the gate of the PMOS is voltage driven, operating current is low and stable over the full load range.

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APPLICATION INFORMATION

sequencing timing diagram

The following figures provide a timing diagram of how this device functions in different configurations.

Application condition; $\overline{MR2}$ is tied to PG1, Vin1 and Vin2 are tied to same input voltage, the SEQ pin is tied to logic low and the device is toggled with enable ($\overline{EN}$) function.

When the device is enabled ($\overline{EN}$ is pulled low) V_{out1} will turn on first and V_{out2} will remain off until V_{out1} reaches to approximately 83% of its regulated output voltage. At that time V_{out2} will be turned on. When V_{out1} reaches to 95% of its regulated output the PG1 will turn on (active high). Since $\overline{MR2}$ is connected to PG1 for this application, it will follow the logic of PG1. When V_{out2} reaches to 95% of its regulated voltage, $\overline{RESET}$ will switch to high voltage level after 120ms delay (see Figure 37).
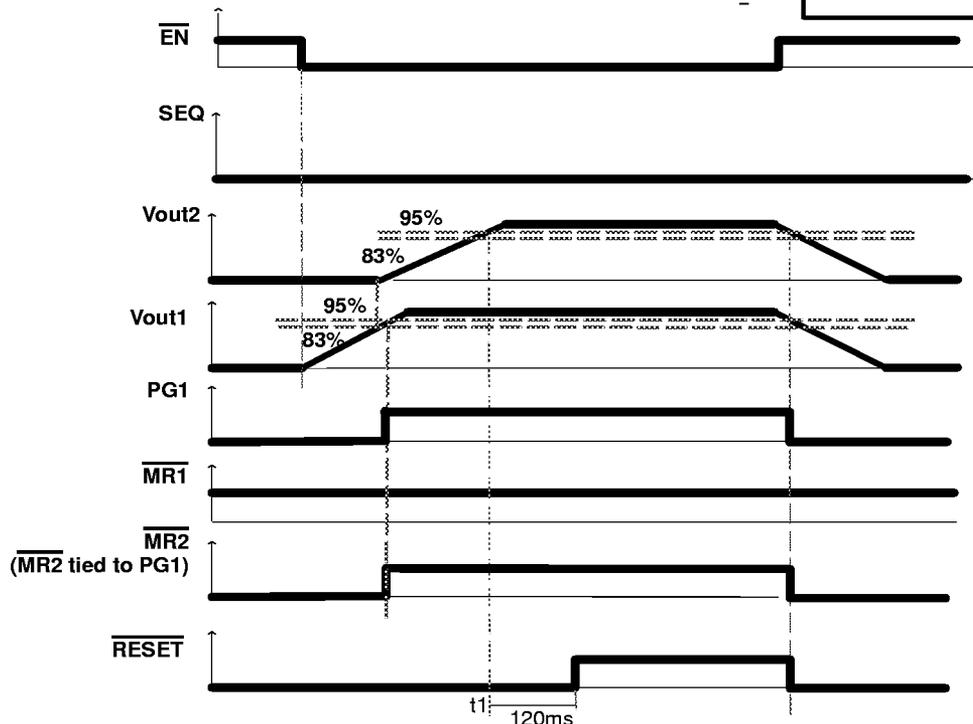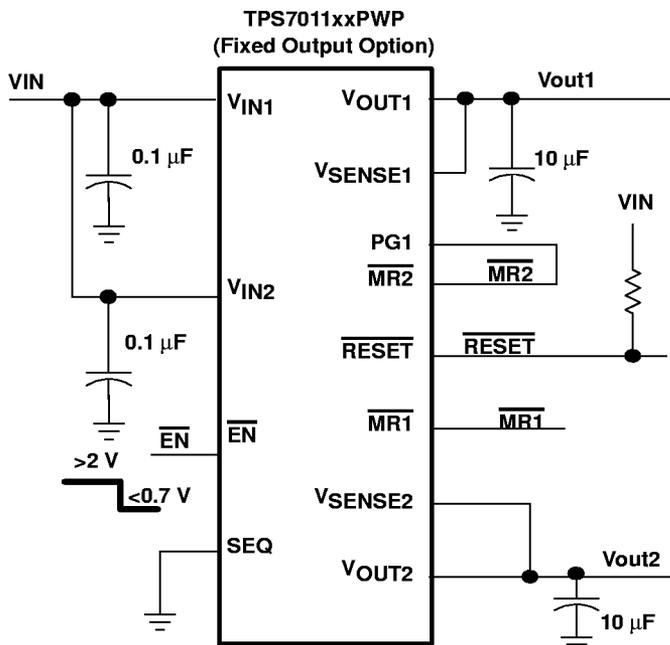
Figure 37. Timing When SEQ = Low

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Application condition; $\overline{MR2}$ is tied to PG1, Vin1 and Vin2 are tied to same input voltage, the SEQ pin is tied to logic high and the device is toggled with enable ($\overline{EN}$) function.

When the device is enabled ($\overline{EN}$ is pulled low), V_{out2} will begin to power up and when it reaches to 83% of its regulated voltage, V_{out1} will begin to power up. PG1 will turn on when Vout1 reaches 95% of its regulated voltage, and since $\overline{MR2}$ and PG1 is tied together, $\overline{MR2}$ will follow the logic of the PG1 output. When V_{out1} reaches 95% of its regulated voltage, $\overline{RESET}$ will switch to high voltage level after 120 ms delay (see Figure 38).
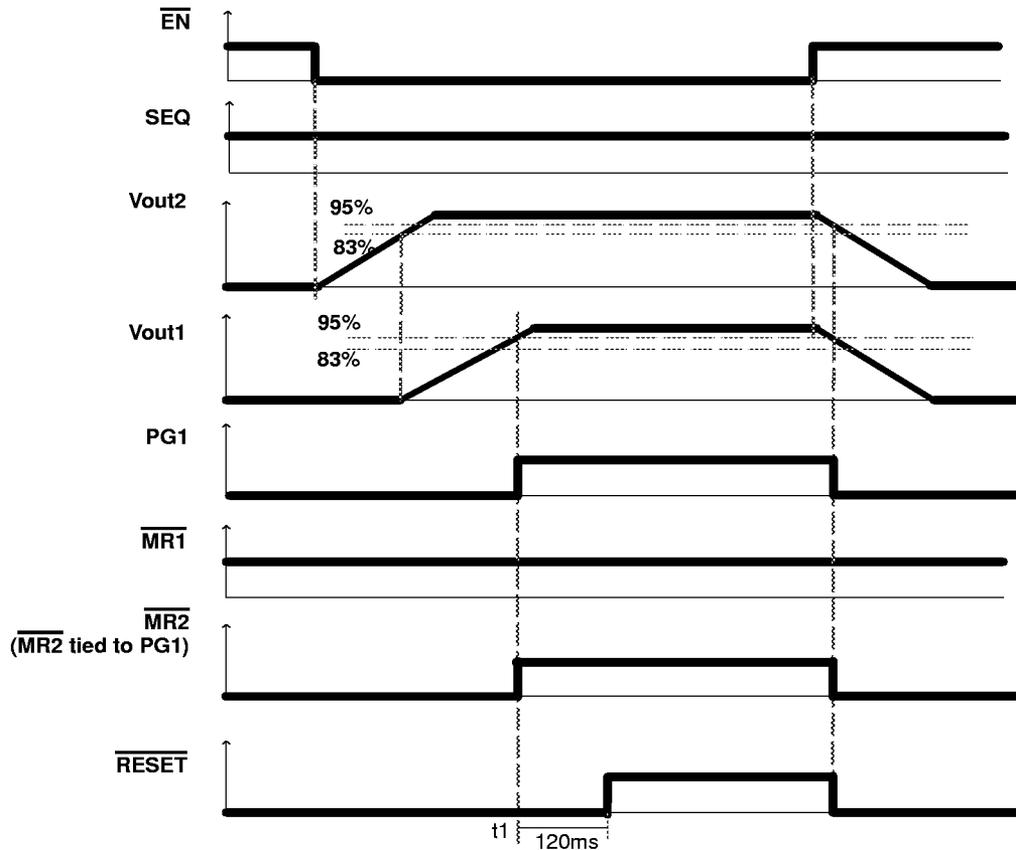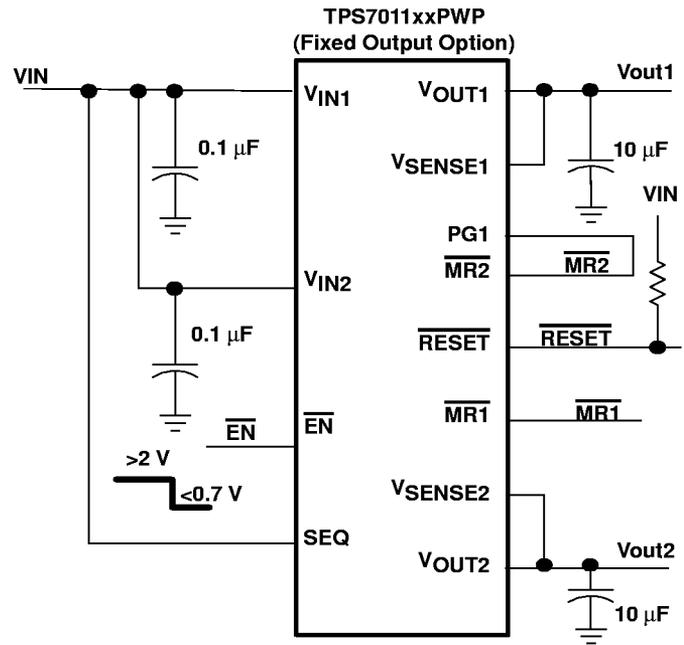

Figure 38. Timing When SEQ = High

APPLICATION INFORMATION

Application condition; $\overline{MR2}$ is tied to PG1, Vin1 and Vin2 are tied to same input voltage, the SEQ pin is tied to logic high and $\overline{MR1}$ is toggled.

When the device is enabled ($\overline{EN}$ is pulled low), V_{out2} will begin to power up and when it reaches to 83% of its regulated voltage, V_{out1} will begin to power up. PG1 will turn on when Vout1 reaches to 95% of its regulated voltage, and since the $\overline{MR2}$ and PG1 is tied together, $\overline{MR2}$ will follow the logic of the PG1 output. When V_{out1} reaches to 95% of its regulated voltage, the $\overline{RESET}$ will switch to high voltage level after 120 ms delay. When $\overline{MR1}$ is toggled, it causes $\overline{RESET}$ to occur but the regulators will remain in regulation. (see Figure 39)
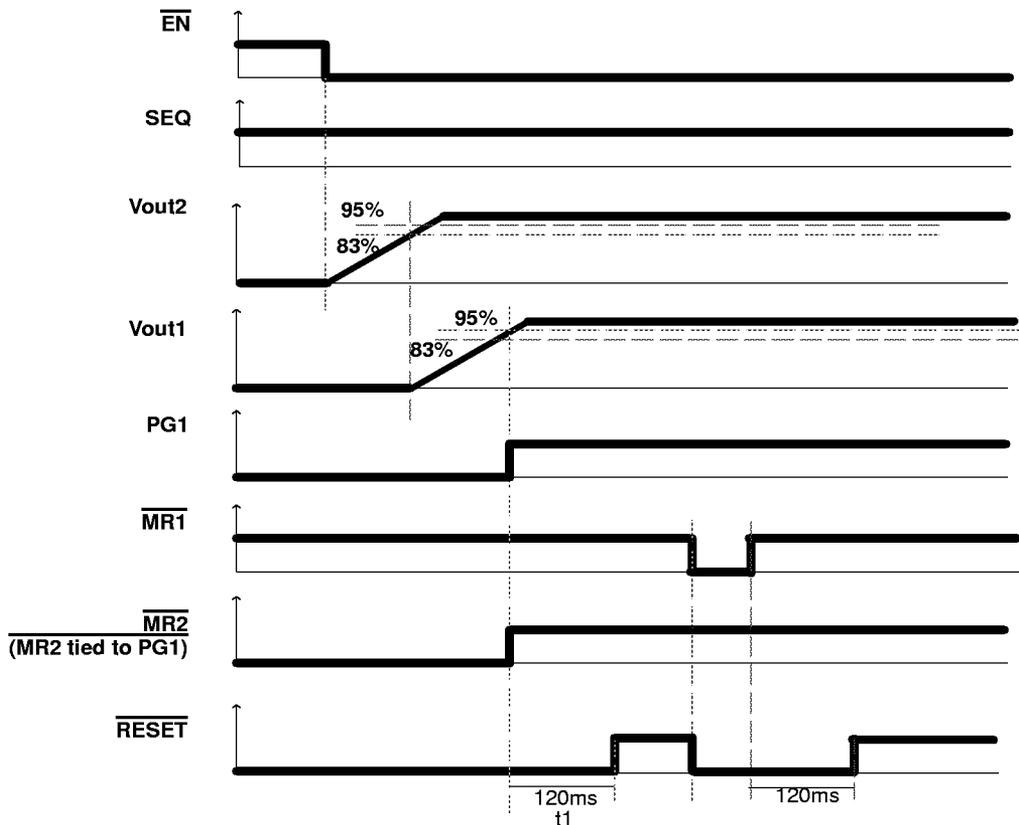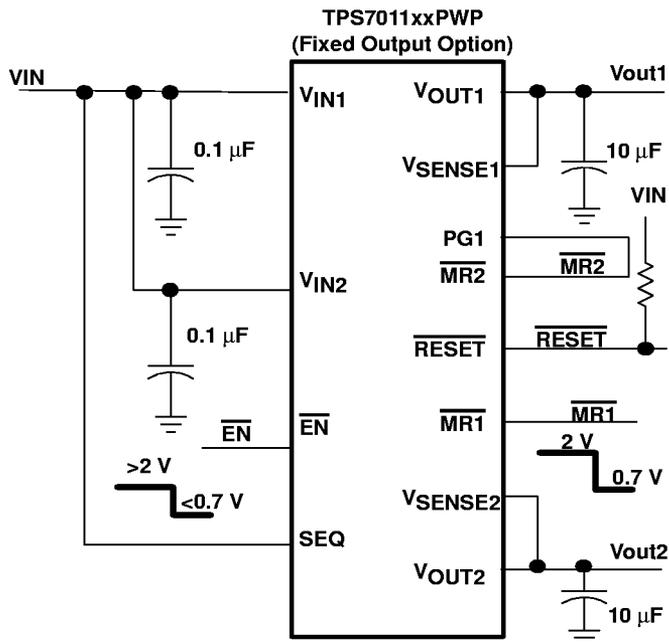
Figure 39. Timing When $\overline{MR1}$ is Toggled

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Application condition; $\overline{MR2}$ is tied to PG1, Vin1 and Vin2 are tied to same input voltage, the SEQ pin is tied to logic high and VOUT1 faults out.

V_{out2} will begin to power up when device is enabled ($\overline{EN}$ is pulled low). When V_{out2} reaches 83% of its regulated voltage, then V_{out1} will begin to power up.

When V_{out1} reaches 95% of its regulated voltage, the PG1 will turn on and $\overline{RESET}$ will switch to high voltage level after 120 ms delay. When Vout1 faults out, Vout2 remains powered on. PG1 is tied to $\overline{MR2}$ and they change state to logic low. $\overline{RESET}$ will be driven by Vout1. (see Figure 40).
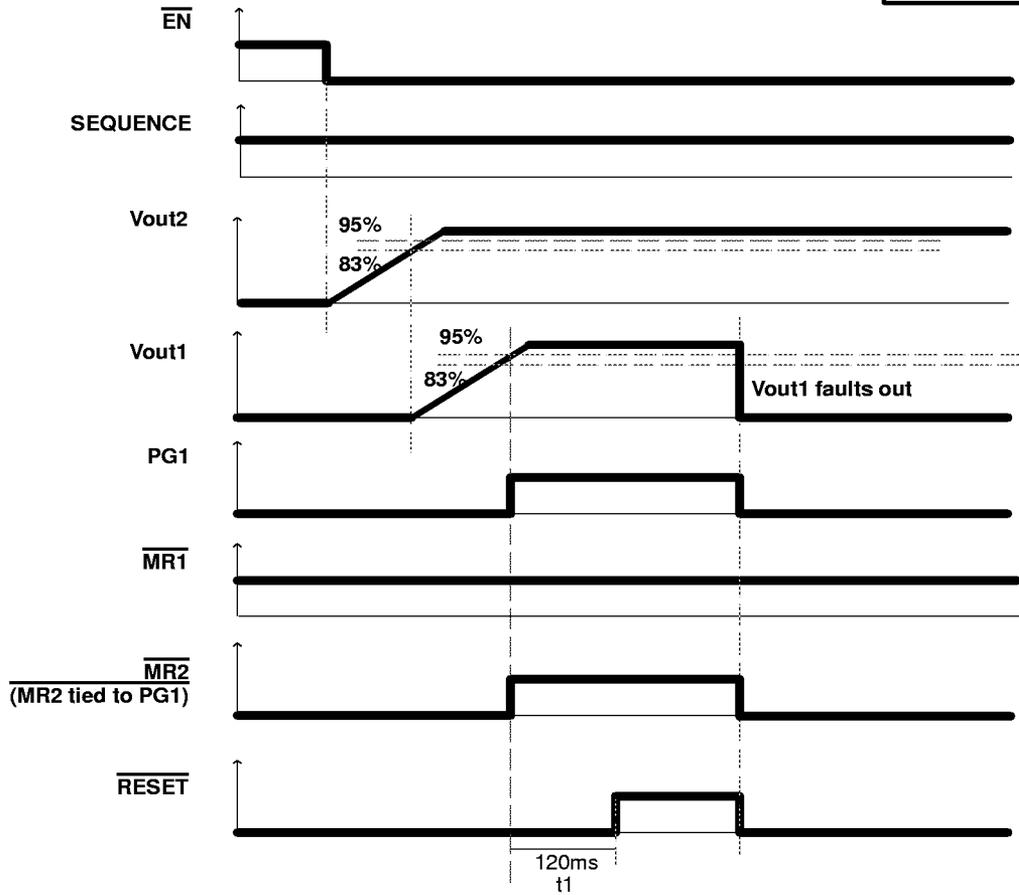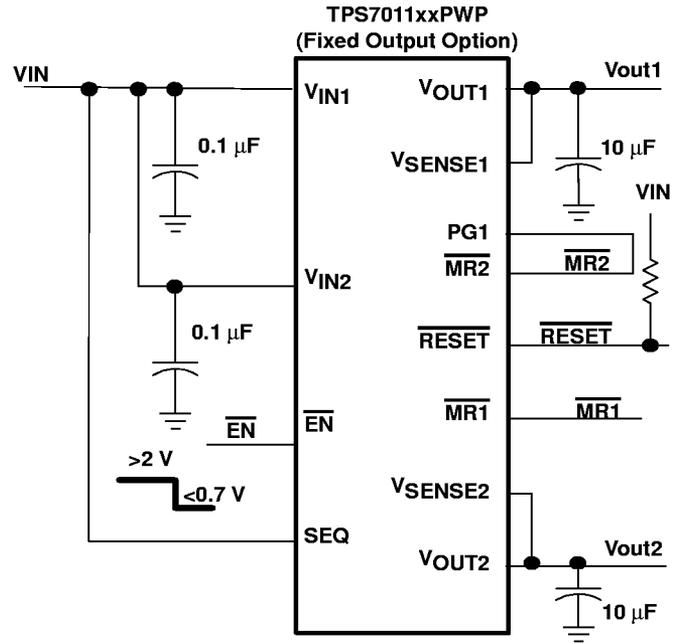
t1 – V_{out1} and V_{out2} are greater than the PG thresholds and $\overline{MR1}$ is logic high.

Figure 40. Timing When VOUT1 Faults Out

APPLICATION INFORMATION

Application condition; $\overline{MR2}$ is tied to PG1, Vin1 and Vin2 are tied to same input voltage, the SEQ is tied to logic high, device is enabled, and VOUT2 faults out.

When Vout2 faults out. V_{out2} will begin to power up when device is enabled ($\overline{EN}$ is pulled low). When V_{out2} reaches 95% of its regulated voltage, then V_{out1} will begin to power up. When V_{out1} reaches 95% of its regulated voltage, PG1 will turn on and $\overline{RESET}$ will switch to high voltage level after 120 ms delay. When Vout2 faults out, Vout1 will be powered down. PG1 is tied to MR2 and they change state to logic low. $\overline{RESET}$ will be driven by Vout2.(see Figure 41).

Figure 41. Timing When VOUT2 Faults Out

t1 – V_{out1} and V_{out2} are greater than the PG thresholds and $\overline{MR1}$ is logic high.

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APPLICATION INFORMATION

split voltage DSP application

Figure 42 shows a typical application where the TPS70151 is powering up a DSP. In this application by grounding the SEQ pin, Vout1(I/O) will be powered up first, and then Vout2(core).
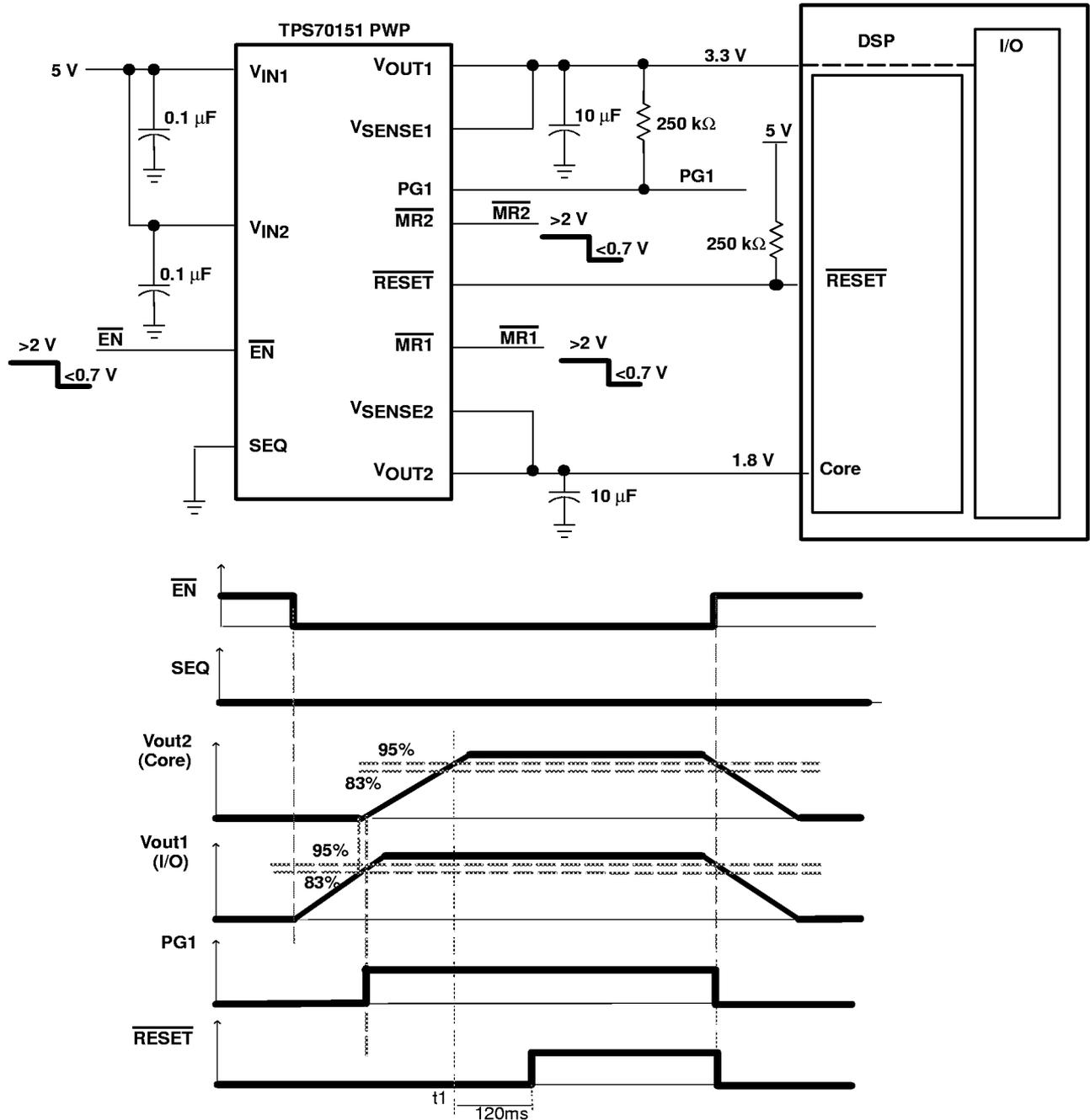
Figure 42. Application Timing Diagram (SEQ = Low)

APPLICATION INFORMATION

split voltage DSP application

Figure 43 shows a typical application where the TPS70151 is powering up a DSP. In this application by pulling up the SEQ pin, Vout2(Core) will be powered up first, and then Vout1(I/O).
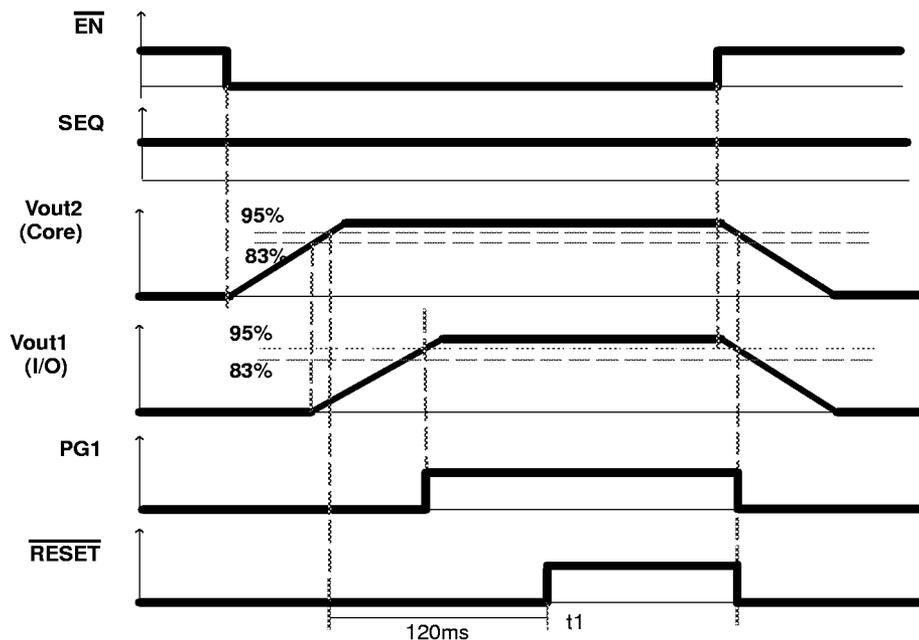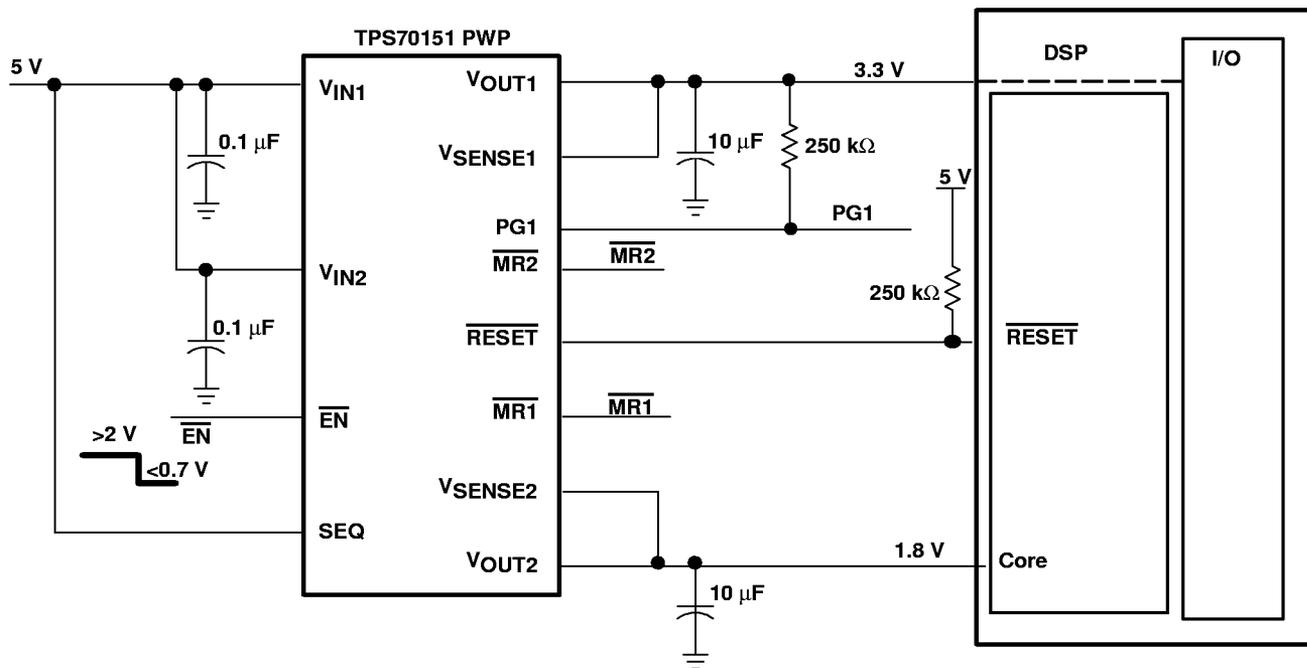

Figure 43. Application Timing Diagram (SEQ = High)

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input capacitor

For a typical application, an input bypass capacitor (0.1 μF – 1 μF) is recommended. This capacitor will filter any high frequency noise generated in the line. For fast transient condition where droop at the input of the LDO may occur due to high inrush current, it is recommended to place a larger capacitor at the input as well. The size of this capacitor is dependant on the output current and response time of the main power supply, as well as the distance to the load(LDO).

output capacitor

As with most LDO regulators, the TPS701xx requires an output capacitor connected between OUT and GND to stabilize the internal control loop. The minimum recommended capacitance value is 10 μF and the ESR (equivalent series resistance) must be between 1 mΩ and 2.5 Ω. Capacitor values 10 μF or larger are acceptable, provided the ESR is less than 2.5 Ω. Solid tantalum electrolytic, aluminum electrolytic, and multilayer ceramic capacitors are all suitable, provided they meet the requirements described above. Larger capacitors provide a wider range of stability and better load transient response. Below is a partial listing of surface-mount capacitors usable with the TPS701xx. for fast transient response application.

This information, along with the ESR graphs, is included to assist in selection of suitable capacitance for the user's application. When necessary to achieve low height requirements along with high output current and/or high load capacitance, several higher ESR capacitors can be used in parallel to meet the guidelines above.

VALUE	MFR.	MAX ESR†	PART NO.
22 μF	Kemet	345 mΩ	7495C226K0010AS
33 μF	Sanyo	100 mΩ	10TPA33M
47 μF	Sanyo	100 mΩ	6TPA47M
68 μF	Sanyo	45 mΩ	10TPC68M

ESR and transient response

LDOs typically require an external output capacitor for stability. In fast transient response applications, capacitors are used to support the load current while LDO amplifier is responding. In most applications, one capacitor is used to support both functions.

Besides its capacitance, every capacitor also contains parasitic impedances. These parasitic impedances are resistive as well as inductive. The resistive impedance is called equivalent series resistance (ESR), and the inductive impedance is called equivalent series inductance (ESL). The equivalent schematic diagram of any capacitor can therefore be drawn as shown in Figure 44.

$$R_{ESR} \quad L_{ESL} \quad C$$

Figure 44. – ESR and ESL

In most cases one can neglect the effect of inductive impedance ESL. Therefore, the following application focuses mainly on the parasitic resistance ESR.

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APPLICATION INFORMATION

Figure 45 shows the output capacitor and its parasitic impedances in a typical LDO output stage.
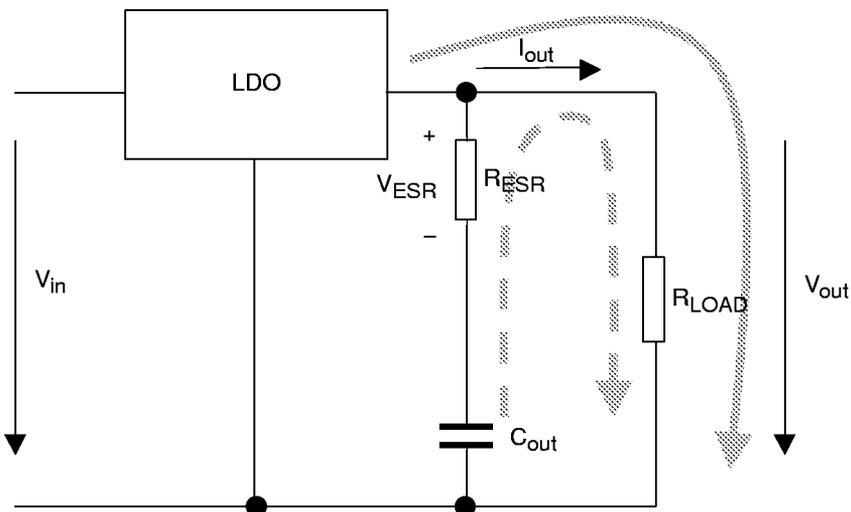

Figure 45. – LDO Output Stage With Parasitic Resistances ESR and ESL

In steady state (dc state condition), the load current is supplied by the LDO (solid arrow) and the voltage across the capacitor is the same as the output voltage ($V_{Cout} = V_{out}$). This means no current is flowing into the C_{out} branch. If I_{out} suddenly increases (transient condition), the following occurs;

The LDO is not able to supply the sudden current need due to its response time (t_1 in Figure 46). Therefore, capacitor C_{out} provides the current for the new load condition (dashed arrow). C_{out} now acts like a battery with an internal resistance, ESR. Depending on the current demand at the output, a voltage drop will occur at R_{ESR}. This voltage is shown as V_{ESR} in Figure 45.

When C_{out} is conducting current to the load, initial voltage at the load will be $V_{out} = V_{Cout} - V_{ESR}$. Due to the discharge of C_{out}, the output voltage V_{out} will drop continuously until the response time t_1 of the LDO is reached and the LDO will resume supplying the load. From this point, the output voltage starts rising again until it reaches the regulated voltage. This period is shown as t_2 in Figure 46.

The figure also shows the impact of different ESRs on the output voltage. The left brackets show different levels of ESRs where number 1 displays the lowest and number 3 displays the highest ESR.

From above, the following conclusions can be drawn:

● The higher the ESR, the larger the droop at the beginning of load transient.

● The smaller the output capacitor, the faster the discharge time and the bigger the voltage droop during the LDO response period.

TEXAS INSTRUMENTS

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TPS70145, TPS70148, TPS70151, TPS70158, TPS70102
DUAL-OUTPUT LOW-DROPOUT VOLTAGE REGULATORS
WITH POWER UP SEQUENCING FOR SPLIT VOLTAGE DSP SYSTEMS

SLVS222 – DECEMBER 1999

APPLICATION INFORMATION

conclusion

To minimize the transient output droop, capacitors must have a low ESR and be large enough to support the minimum output voltage requirement.
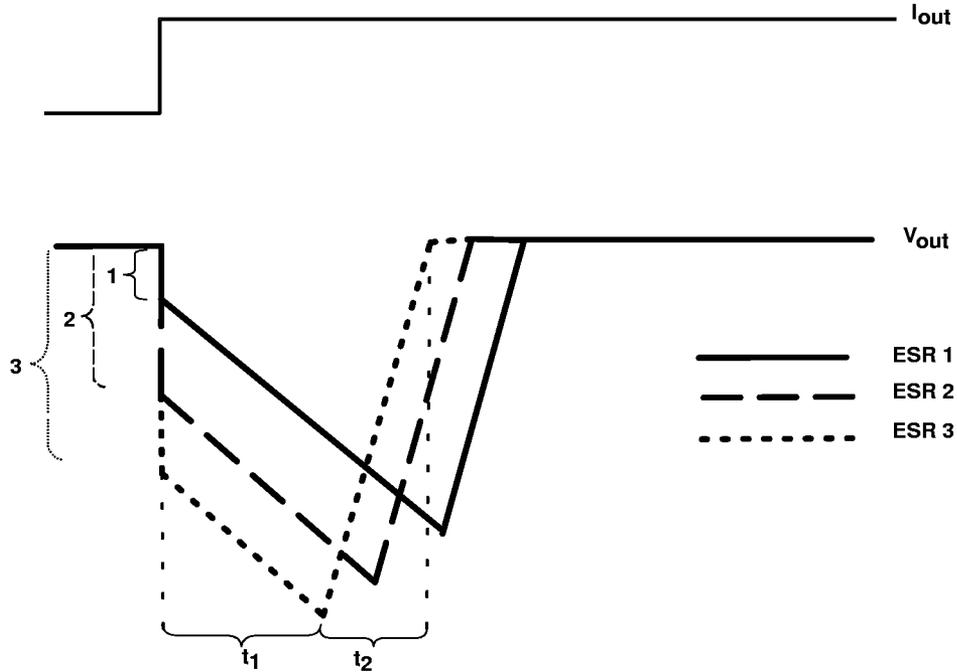

Figure 46. – Correlation of Different ESRs and Their Influence to the Regulation of V_{out} at a Load Step From Low-to-High Output Current

APPLICATION INFORMATION

### programming the TPS70102 adjustable LDO regulator

The output voltage of the TPS70102 adjustable regulators are programmed using external resistor dividers as shown in Figure 47.

Resistors R1 and R2 should be chosen for approximately 7 µA divider current. Lower value resistors can be used, but offer no inherent advantage and waste more power. Higher values should be avoided as leakage currents at the sense terminal increase the output voltage error. The recommended design procedure is to choose R2 = 169 kΩ to set the divider current at approximately 7 µA and then calculate R1 using:

$$R1 = \left(\frac{V_O}{V_{ref}} - 1 \right) \times R2$$

Where

V_{ref} = 1.224 V typ (the internal reference voltage)

TPS70102

Figure 47. TPS70102 Adjustable LDO Regulator Programming
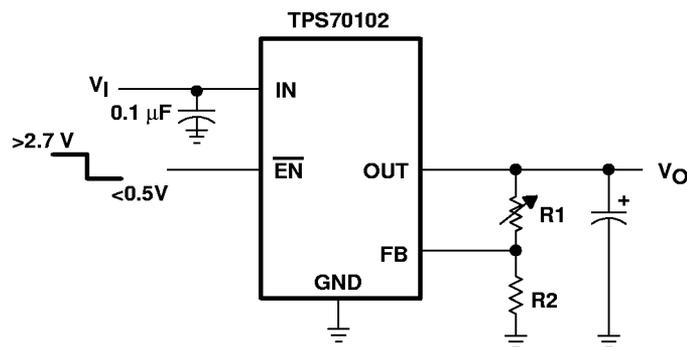
OUTPUT VOLTAGE PROGRAMMING GUIDE

OUTPUT VOLTAGE	R1	R2	UNIT
2.5 V	174	169	kΩ
3.3 V	287	169	kΩ
3.6 V	324	169	kΩ

regulator protection

Both TPS701xx PMOS-pass transistors have built-in back diodes that conduct reverse currents when the input voltage drops below the output voltage (e.g., during power down). Current is conducted from the output to the input and is not internally limited. When extended reverse voltage is anticipated, external limiting may be appropriate.

The TPS701xx also features internal current limiting and thermal protection. During normal operation, the TPS701xx regulator 1 limits output current to approximately 1.6 A (typ) and regulator 2 limits output current to approximately 750 mA (typ). When current limiting engages, the output voltage scales back linearly until the overcurrent condition ends. While current limiting is designed to prevent gross device failure, care should be taken not to exceed the power dissipation ratings of the package. If the temperature of the device exceeds 150°C(typ), thermal-protection circuitry shuts it down. Once the device has cooled below 130°C(typ), regulator operation resumes.

TEXAS INSTRUMENTS

power dissipation and junction temperature

Specified regulator operation is assured to a junction temperature of 125°C; the maximum junction temperature should be restricted to 125°C under normal operating conditions. This restriction limits the power dissipation the regulator can handle in any given application. To ensure the junction temperature is within acceptable limits, calculate the maximum allowable dissipation, $P_{D(max)}$, and the actual dissipation, P_D, which must be less than or equal to $P_{D(max)}$.

The maximum-power-dissipation limit is determined using the following equation:

$$P_{D(max)} = \frac{T_J max - T_A}{R_{\theta JA}}$$

Where

$T_J max$ is the maximum allowable junction temperature.

$R_{\theta JA}$ is the thermal resistance junction-to-ambient for the package, i.e., 32.6°C/W for the 28-terminal PWP with no airflow.

T_A is the ambient temperature.

The regulator dissipation is calculated using:

$$P_D = \left(V_I - V_O\right) \times I_O$$

Power dissipation resulting from quiescent current is negligible. Excessive power dissipation will trigger the thermal protection circuit.

MECHANICAL DATA

PWP (R-PDSO-G)**   **PowerPAD™ PLASTIC SMALL-OUTLINE PACKAGE**

20-PIN SHOWN

PINS ** DIM	14	16	20	24	28
A MAX	5,10	5,10	6,60	7,90	9,80
A MIN	4,90	4,90	6,40	7,70	9,60
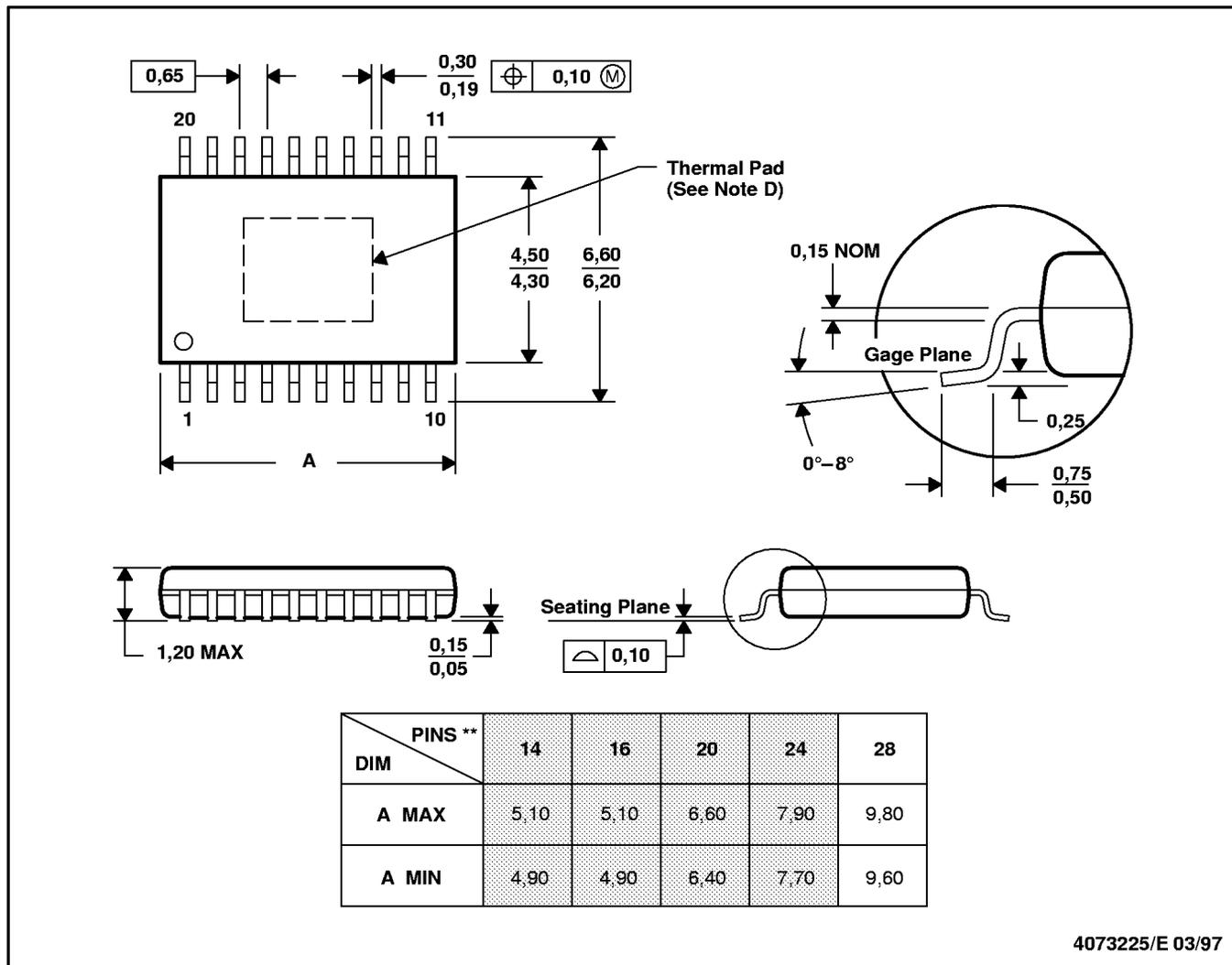
4073225/E 03/97

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusions.
D. The package thermal performance may be enhanced by bonding the thermal pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected leads.
E. Falls within JEDEC MO-153

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